

# ISL68201

Single-Phase R4 Digital Hybrid PWM Controller with PMBus/SMBus/I<sup>2</sup>C and PFM

FN8696 Rev.5.00 Jul 12, 2018

The ISL68201 is a single-phase, synchronous buck PWM controller featuring the Renesas proprietary R4<sup>TM</sup> Technology. It supports a wide 4.5V to 24V input voltage range and a wide 0.5V to 5.5V output range. Integrated LDOs provide controller bias voltage, allowing for single supply operation. The ISL68201 includes a PMBus/SMBus/I $^2$ C interface for device configuration and telemetry (V $_{IN}$ , V $_{OUT}$ , I $_{OUT}$ , and temperature) and fault reporting.

The Renesas proprietary R4 control scheme has extremely fast transient performance, accurately regulated frequency control, and all internal compensation. An efficiency enhancing PFM mode can be enabled to greatly improve light-load efficiency. The ISL68201's serial bus allows for easy R4 loop optimization, resulting in fast transient performance over a wide range of applications, including all ceramic output filters.

The ISL68201 has four 8-bit configuration pins, which provide very flexible configuration options (frequency,  $V_{OUT}$ , R4 gain, etc.) without the need for built-in NVM memory. This results in a design flow that closely matches traditional analog controllers, while still offering the design flexibility and feature set of a digital PMBus/SMBus/I $^2$ C interface. The ISL68201 also features remote voltage sensing and completely eliminates any potential difference between remote and local grounds. This improves regulation and protection accuracy. A precision enable input is available to coordinate the start-up of the ISL68201 with other voltage rails, especially useful for power sequencing.

# **Applications**

- · High efficiency and high density POL digital power
- FPGA, ASIC, and memory supplies
- · Data center: servers, storage systems
- Wired infrastructure: routers, switches, and optical networking
- · Wireless infrastructure: base stations

# **Related Literature**

For a full list of related documents, visit our website

• ISL68201 product page

# **Features**

- Renesas proprietary R4 Technology
  - Linear control loop for optimal transient response
- Variable frequency and duty cycle control during load transient for fastest possible response
- Inherent voltage feed-forward for wide range input
- · Input voltage range: 4.5V to 24V
- · Output voltage range: 0.5V to 5.5V
- ±0.5% DAC accuracy with remote sense
- · Support all ceramic solutions
- · Integrated LDOs for single input rail solution
- SMBus/PMBus/I<sup>2</sup>C compatible, up to 1.25MHz
- · 256 boot-up voltage levels with a configuration pin
- Eight switching frequency options from 300kHz to 1.5MHz
- PFM operation option, compatible with ISL99140 for improved light-load efficiency
- · Start-up into precharged load
- Precision enable input to set higher input UVLO and power sequence as well as fault reset
- · Power-good monitor for soft-start and fault detection
- · Comprehensive fault protection for high system reliability
  - Over-temperature protection
  - Output overcurrent and short-circuit protection
- Output overvoltage and undervoltage protection
- Open remote sense protection
- Compatible with 5V or 3.3V PWM input DrMOS or Smart Power Stage (SPS)
- Compatible with **PowerNavigator** software

# TABLE 1. SINGLE-PHASE R4 DIGITAL HYBRID PWM CONTROLLER OPTIONS

PART NUMBER	INTEGRATED DRIVER	PWM OUTPUT	PMBus/SMBus/I <sup>2</sup> C INTERFACE	COMPATIBLE DEVICES
ISL68200	Yes	No	Yes	Discrete MOSFETs or Dual Channel MOSFETs
ISL68201	No	Yes	Yes	Renesas Power Stages: ISL99140, ISL99227, ISL99125B, ISL99135B Renesas Drivers: ISL6596, ISL6609, ISL6627, ISL6622, ISL6208

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# **Typical Applications Circuits**

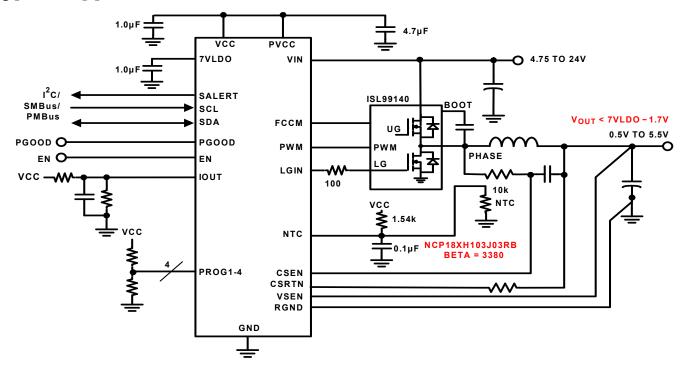


FIGURE 1. WIDE RANGE INPUT AND OUTPUT APPLICATIONS

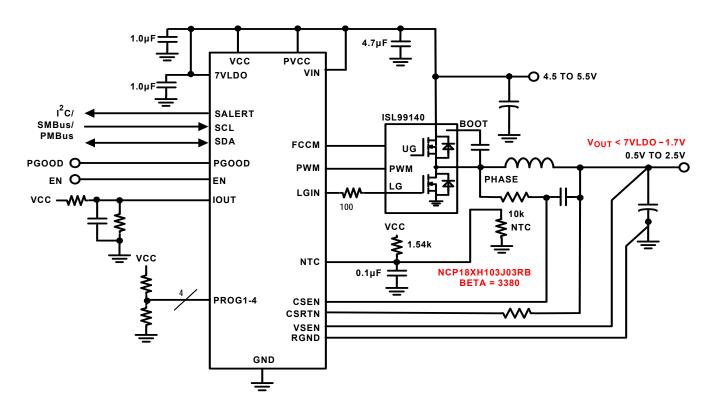
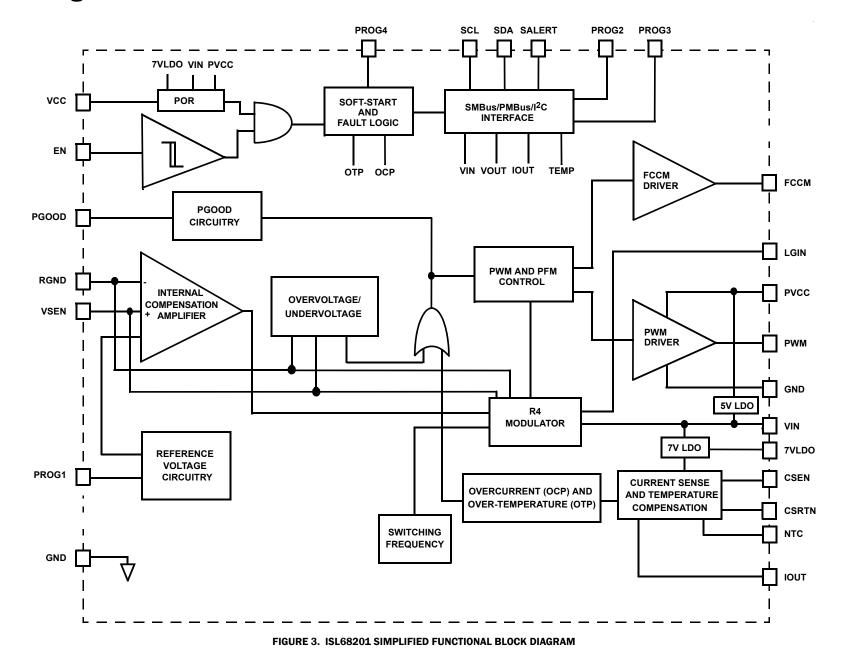


FIGURE 2. 5V INPUT APPLICATION

# **Block Diagram**



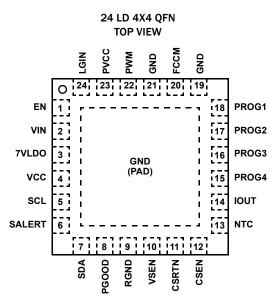
# **Ordering Information**

PART NUMBER (Notes 2, 3)	PART MARKING	TEMP RANGE (°C)	TAPE AND REEL (UNITS) (Note 1)	PACKAGE (RoHS Compliant)	PKG. DWG. #		
ISL68201IRZ	ISL 68201I	-40 to +85	-	24 Ld 4x4 QFN	L24.4x4C		
ISL68201IRZ-T	ISL 68201I	-40 to +85	6k	24 Ld 4x4 QFN	L24.4x4C		
ISL68201IRZ-T7A	ISL 68201I	-40 to +85	250	24 Ld 4x4 QFN	L24.4x4C		
ISL68201IRZ-TK	ISL 68201I	-40 to +85	1k	24 Ld 4x4 QFN	L24.4x4C		
ISL68201-99125DEM01Z	16A Demo Board with On-Board Transient						
ISL68201-99135DEM01Z	20A Demo Board with On-Board Transient						
ISL68201-99140DEM01Z	35A Demo Board with On-Board Transient						

#### NOTES:

- 1. Refer to TB347 for details about reel specifications.
- These Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate
  plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Pb-free products are
  MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 3. For Moisture Sensitivity Level (MSL), see the ISL68201 product information page. For more information about MSL, see TB363.

# **Pin Configuration**



# **Functional Pin Descriptions**

PIN NUMBER	SYMBOL	DESCRIPTION
1	EN	Precision enable input. Pulling EN above the rising threshold voltage initiates the soft-start sequence, while pulling EN below the failing threshold voltage suspends the Voltage Regulator (VR) operation.
2	VIN	Input voltage pin for the R4 loop and LDOs (5V and 7V). Place a high quality low ESR ceramic capacitor (1.0μF, X7R) in close proximity to the pin. An external series resistor is not advised.
3	7VLD0	7V LDO from VIN biases the current sensing amplifier. Place a high quality low ESR ceramic capacitor (1.0μF, X7R, 10V+) in close proximity to the pin.
4	vcc	Logic bias supply that should be connected to PVCC rail externally. Place a high quality low ESR ceramic capacitor (1μF, X7R) from this pin to GND.
5	SCL	Synchronous clock signal input of SMBus/PMBus/I <sup>2</sup> C.
6	SALERT	Output pin for transferring the active low signal driven asynchronously from the VR controller to the SMBus/PMBus.
7	SDA	I/O pin for transferring data signals between the SMBus/PMBus/I <sup>2</sup> C host and VR controller.



# Functional Pin Descriptions (Continued)

PIN NUMBER	SYMBOL	DESCRIPTION
8	PGOOD	Power-good, open-drain indicator output.
9	RGND	This pin monitors the negative rail of the regulator output. Connect to ground at the point of regulation.
10	VSEN	This pin monitors the positive rail of the regulator output. Connect to the point of regulation.
11	CSRTN	This pin monitors the negative flow of output current with a series resistor and for overcurrent protection and telemetry. The series resistor sets the current gain and should be within $40\Omega$ and $3.5k\Omega$ .
12	CSEN	This pin monitors the positive flow of output current for overcurrent protection and telemetry.
13	NTC	Input pin for the temperature measurement. Connect this pin through an NTC thermistor ( $10k\Omega$ , $\beta$ ~ 3380) and a decoupling capacitor ( $\sim$ 0.1 $\mu$ F) to GND, and a resistor ( $1.54k\Omega$ ) to VCC of the controller. The voltage at this pin is inversely proportional to the VR temperature.
14	IOUT	Output current monitor pin. An external resistor sets the gain and an external capacitor provides the averaging function; an external pull-up resistor to VCC is recommended to calibrate the no load offset. See "I <sub>OUT</sub> Calibration" on page 19.
15	PROG4	Programming pin for Modulator (R4) RR impedance and output slew rate during Soft-Start (SS) and Dynamic VID (DVID). It also sets AV gain multiplier to 1x or 2x and determines the AV gain on PROG3.
16	PROG3	Programming pin for ultrasonic PFM operation, fault behavior, switching frequency, and R4 (AV) control loop gain.
17	PROG2	Programming pin for PWM/PFM mode, temperature compensation, and serial bus (SMBus/PMBus/I <sup>2</sup> C) address.
18	PROG1	Programming pin for boot-up voltage.
19, 21	GND	Ground pin, connect directly to system ground plane.
20	FCCM	Output signal low to work with DrMOS ISL99140 for diode emulation in PFM mode; signal high for PWM mode.
22	PWM	PWM output and is compatible with 3.3V or 5V PWM input external driver, DrMOS, or Smart Power Stage.
23	PVCC	Output of the 5V LDO and input for the LGATE and UGATE MOSFET driver circuits. Place a high quality low ESR ceramic capacitor (4.7µF or higher, X7R) in close proximity to the pin.
24	LGIN	Low-side gate signal input to complete the internal FLL loop. A $100\Omega$ series impedance from low-side gate drive signal to this pin is required.
PAD	GND	Return of logic bias supply VCC. Connect directly to the system ground plane with at least four vias.



# **Absolute Maximum Ratings**

VCC, PVCC, VSEN0.3V to +7.0V
Input Voltage, VIN
7VLDO0.3V to GND, 7.75V
All Other Pins0.3V to GND, VCC + 0.3V
ESD Rating
Human Body Model (Tested per JS-001-2010)2.5kV
Machine Model (Tested per JESD22-A115C) 200V
Charge Device Model (Tested per JS-002-2014) 1kV
Latch-Up (Tested per JESD78D, Class 2, Level A)±100mA at +125°C

# **Thermal Information**

Thermal Resistance (Typical)	$\theta_{JA}$ (°C/W)	$\theta_{JC}$ (°C/W)
24 Ld QFN (Notes 4, 5)	39	2.5
Junction Temperature Range	5	5°C to +150°C
Storage Temperature	6	5°C to +150°C
Pb-Free Reflow Profile		see <u>TB493</u>

# **Recommended Operating Conditions**

Ambient Temperature Range	40°C to +85°C
Wide Range Input Voltage, V <sub>IN</sub> , Figure 1	4.75V to 24V
5V Application Input Voltage, V <sub>IN</sub> , V <sub>CC</sub> , PVCC, Figure 2	4.5V to 5.5V

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

#### NOTES:

- 4. θ<sub>JA</sub> is measured in free air with the component mounted on a high-effective thermal conductivity test board with "direct attach" features. See <u>TB379</u>.
- 5. For  $\theta_{\text{JC}}$ , the "case temp" location is the center of the exposed metal pad on the package underside.

# **Electrical Specifications** All typical specifications $T_A = +25 \,^{\circ}$ C, $V_{CC} = 5V$ . Boldface limits apply across the operating temperature range, -40 $^{\circ}$ C to +85 $^{\circ}$ C, unless otherwise stated.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 6)	TYP	MAX ( <u>Note 6</u> )	UNIT
V <sub>CC</sub> AND PVCC	•		•			
V <sub>CC</sub> Input Bias Current	l <sub>vcc</sub>	EN = 5V, V <sub>CC</sub> = 5V, f <sub>SW</sub> = 500kHz, DAC = 1V		14	16.5	mA
		EN = 0V, V <sub>CC</sub> = 5V		14	16.5	mA
PVCC Input Bias Current	I <sub>PVCC</sub>	EN = 5V, V <sub>CC</sub> = 5V, f <sub>SW</sub> = 500kHz, DAC = 1V		2		mA
		EN = 0V, V <sub>CC</sub> = 5V			1.0	mA
V <sub>CC</sub> AND V <sub>IN</sub> POR THRESHOLD			-			
V <sub>CC</sub> , PVCC Rising POR Threshold Voltage				4.2	4.35	V
V <sub>CC</sub> , PVCC Falling POR Threshold Voltage			3.80	3.95	4.15	V
V <sub>IN</sub> , 7VLDO Rising POR Threshold Voltage				4.2	4.35	V
V <sub>IN</sub> , 7VLDO Falling POR Threshold Voltage			3.80	3.95	4.15	V
ENABLE INPUT			-			
EN High Threshold Voltage	V <sub>ENTHR</sub>		0.81	0.84	0.87	V
EN Low Threshold Voltage	V <sub>ENTHF</sub>		0.71	0.76	0.81	٧
DAC ACCURACY			-			
DAC Accuracy		2.5V < DAC ≤ 5.5V	-0.5		0.5	%
$(T_A = 0 \degree C \text{ to } +85 \degree C)$		1.6V < DAC ≤ 2.5V	-0.75		0.75	%
		1.2V < DAC ≤ 1.6V	-10		10	m۷
		0.5V ≤ DAC ≤ 1.2V	-8		8	m۷
DAC Accuracy		2.5V < DAC ≤ 5.5V	-0.75		0.75	%
$(T_A = -45^{\circ}C \text{ to } +85^{\circ}C)$		1.6V < DAC ≤ 2.5V	-1.0		1.0	%
		1.2V < DAC ≤ 1.6V	-11		11	тV
		0.5V ≤ DAC ≤ 1.2V	-9		9	m۷
CHANNEL FREQUENCY	1			1		
300kHz Configuration		PWM mode	260	300	335	kHz
400kHz Configuration		PWM mode	345	400	450	kHz



# **Electrical Specifications** All typical specifications $T_A = +25 \,^{\circ}$ C, $V_{CC} = 5V$ . Boldface limits apply across the operating temperature range, -40 $^{\circ}$ C to +85 $^{\circ}$ C, unless otherwise stated. (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 6)	TYP	MAX ( <u>Note 6</u> )	UNIT
500kHz Configuration		PWM mode	435	500	562	kHz
600kHz Configuration		PWM mode	510	600	670	kHz
700kHz Configuration		PWM mode	610	700	790	kHz
850kHz Configuration		PWM mode	730	850	950	kHz
1000kHz Configuration		PWM mode	865	1000	1120	kHz
1500kHz Configuration		PWM mode	1320	1500	1660	kHz
SOFT-START AND DYNAMIC VID						,
Soft-Start and DVID Slew Rate			0.0616	0.078	0.096	mV/μs
			0.13	0.157	0.18	mV/μs
			0.25	0.315	0.37	mV/μs
			0.53	0.625	0.70	mV/μs
			1.05	1.25	1.40	mV/μs
			2.10	2.50	2.80	mV/μs
			4.20	5.00	5.60	mV/μs
			8.60	10.0	10.9	mV/μs
Soft-Start Delay from Enable High		Excluding 5.5ms POR timeout. See Figures 21 and 22	140	200	260	μs
REMOTE SENSE						<u>I</u>
Bias Current of VSEN and RGND Pins					250	μΑ
Maximum Differential Input Voltage			6.0			V
POWER-GOOD						1
PGOOD Pull-Down Impedance	R <sub>PG</sub>	PGOOD = 5mA sink		10	50	Ω
PGOOD Leakage Current	I <sub>PG</sub>	PGOOD = 5V			1.0	μΑ
LDOs			ll .			
5V LDO Regulation		V <sub>IN</sub> = 12V, load = 50mA	4.85	5.00	5.15	V
5V Dropout		V <sub>IN</sub> = 4.75V, load = 50mA	4.45			V
5V LDO Current Capability			125			mA
7V LDO Regulation		250μA load	7.2	7.4	7.5	V
7V Dropout		V <sub>IN</sub> = 4.75V, 250μA load	4.50			V
7V LDO Current Capability		Not recommended for external use	2			mA
CURRENT SENSE			ll .			
Average OCP Trip Level	I <sub>OC_TRIP</sub>		82	100	123	μΑ
Short-Circuit Protection Threshold				130		% I <sub>OCP</sub>
Sensed Current Tolerance			74	78	83	μΑ
Sensed Current Tolerance			35	38	42	μΑ
Maximum Common-Mode Input Voltage		7VLD0 = 7.4V	5.7			V
		VCC = PVCC = 7VLDO = 4.5V	2.8			V



# **Electrical Specifications** All typical specifications $T_A = +25 \,^{\circ}$ C, $V_{CC} = 5V$ . Boldface limits apply across the operating temperature range, -40 $^{\circ}$ C to +85 $^{\circ}$ C, unless otherwise stated. (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN ( <u>Note 6</u> )	TYP	MAX ( <u>Note 6</u> )	UNIT
FAULT PROTECTION	II.		<b>"</b>	<u> </u>		Į.
UVP Threshold Voltage		Latch	68	74	80	% DAC
Start-Up OVP Threshold Voltage		0V ≤ V <sub>BOOT</sub> ≤ 1.08V	1.10	1.15	1.25	V
		1.08V < V <sub>BOOT</sub> ≤ 1.55V	1.58	1.65	1.75	V
		1.55V < V <sub>BOOT</sub> ≤ 1.85V	1.88	1.95	2.05	V
		1.85V < V <sub>BOOT</sub> ≤ 2.08V	2.09	2.15	2.25	V
		2.08V < V <sub>BOOT</sub> ≤ 2.53V	2.56	2.65	2.75	V
		2.53V < V <sub>BOOT</sub> ≤ 3.33V	3.36	3.45	3.6	٧
		3.33V < V <sub>BOOT</sub> ≤ 5.5V	5.52	5.65	5.85	V
Start-Up OVP Hysteresis				100		m۷
OVP Rising Threshold Voltage	V <sub>OVRTH</sub>	0.5 ≤ DAC ≤ 5.5	114	120	127	% DAC
OVP Falling Threshold Voltage	V <sub>OVFTH</sub>	0.5 ≤ DAC ≤ 5.5	96	100	108	% DAC
Over-Temperature Shutdown Threshold		READ_TEMP = 72h	20	22.31	26	% VCC
Over-Temperature Shutdown Reset Threshold		READ_TEMP = 8Eh	25	27.79	30	% VCC
SMBus/PMBus/I <sup>2</sup> C	ı					
Signal Input Low Voltage					1	٧
Signal Input High Voltage			1.6			V
Signal Output Low Voltage		4mA pull-up current			0.4	V
DATE, ALERT # Pull-Down Impedance				11	50	Ω
CLOCK Maximum Speed			1.25			MHz
CLOCK Minimum Speed					0.05	MHz
Telemetry Update Rate				108		μs
Timeout			25	30	35	ms
PMBus Accessible Timeout from All Rails' POR		See Figure 21		5.5	6.5	ms

#### NOTE:

 $<sup>\</sup>textbf{6. Compliance to datasheet limits is assured by one or more methods: production test, characterization, and/or design.}\\$ 

# **Operation**

The following sections provide a detailed description of the ISL68201 operation.

## **IC Supplies**

The ISL68201 has four bias pins: VIN, 7VLDO, PVCC, and VCC. The PVCC and 7VLDO voltage rails are 5V LDO and 7.4V LDO supplied by VIN, respectively, while the VCC pin needs to connect to the PVCC rail externally to be biased. For 5V input applications, all these pins should be tied together and biased by a 5V supply. Because the VIN pin voltage information is used by the R4 Modulator loop, the user CANNOT bias VIN with a series resistor. In addition, the VIN pin CANNOT be biased independently from other rails.

## **Enable and Disable**

The IC is disabled until the 7VLDO, PVCC, VCC, VIN, and EN pins increase above their respective rising threshold voltages and the typical 5.5ms timeout (worst case = 6.5ms) expires, as shown in Figures 21 and 22 on page 22. The controller becomes disabled when the 7VLDO, PVCC, VCC, VIN, or EN pins drop below their respective falling POR threshold voltages.

The precision threshold EN pin allows the user to set a precision input UVLO level with an external resistor divider, as shown in Figure 4. For 5V input applications or wide range input applications, the EN pin can directly connect to VCC, as shown in Figure 5. If an external enable control signal is available and is an open-drain signal, a pull-up impedance (100k or higher) can be used.

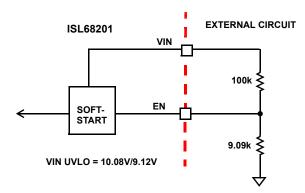
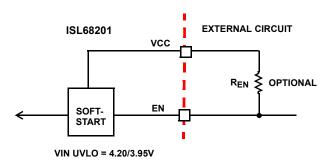


FIGURE 4. INPUT UVP CONFIGURATION



R<sub>EN</sub> is needed ONLY if the user wants to control the IC with an external enable signal

FIGURE 5. 5V INPUT OR WIDE RANGE INPUT CONFIGURATION

In addition, based on the ON\_OFF\_CONFIG [02h] setting, the IC can be enabled or disabled by the serial bus command "OPERATION [01h]" and/or EN pin. See <u>Table 11 on page 25</u> for more details.

#### **Resistor Reader**

The ISL68201 offers four programming pins to customize their regulator specifications. The details of these pins are summarized in <u>Table 2</u>, followed by the detailed description of resistor reader operation.

**TABLE 2. DEFINITION OF PROG PINS** 

PIN	BIT	NAME	DESCRIPTION
PROG1	[7:0]	BOOT-UP VOLTAGE	Sets output boot-up voltage, 256 different options: 0, 0.5V to 5.5V (see Table 7)
PROG2	[7:7]	PWM/PFM	Enables PFM mode or forced PWM.
	[6:5]	Temperature Compensation	Adjusts NTC temperature compensation: OFF, +5, +15, +30°C.
	[4:0]	ADDR	Sets serial bus 32 different addresses (see Table 10).
PROG3	[7:7]	USPFM	Ultrasonic (25kHz clamp) PFM enable
	[6:6]	Fault Behavior	OCP fault behavior: Latch, infinite 9ms retry
	[5:3]	f <sub>SW</sub>	Sets switching frequency (f <sub>SW</sub> ).
	[2:0]	R4 Gain	Sets error amplifier gain (AV).
PROG4	[7:5]	RAMP_RATE	Sets soft-start and DVID ramp rate.
	[4:3]	RR	Selects RR impedance for R4 loop.
	[2:2]	AVMLTI	Selects AV gain multiplier (1x or 2x)
	[1:0]	Not Used	

Renesas has developed a high resolution ADC using a technique with a simple 1%, 100ppm/K or better temperature coefficient resistor divider. The same type of resistors are preferred so that it has similar change over temperature. In addition, the divider is compared to the internal divider off  $V_{CC}$  and GND nodes and therefore must refer to VCC and GND pins, not through any RC decoupling network.

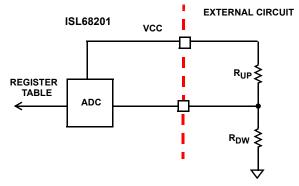


FIGURE 6. SIMPLIFIED RESISTOR DIVIDER ADC



The  $R_{UP}$  and  $R_{DW}$  values for a particular parameter set can be found using the PowerNavigator GUI. Data for corresponding registers can be read out using the serial PMBus command (DC to DF). Note: The case of  $10 k\Omega~R_{UP}$  or  $R_{DW}$  is the same as  $0 k\Omega~R_{UP}$  or  $R_{DW}$ .

TABLE 3. PROG 1 RESISTOR READER EXAMPLE

PROG1 (DC)	R <sub>UP</sub> (kΩ)	R <sub>DW</sub> (kΩ)	V <sub>ОUТ</sub> (V)
00h	Open	0	0.797
20h	Open	21.5	0.852
40h	Open	34.8	0.898
60h	Open	52.3	0.953
80h	Open	75	1.000
A0h	Open	105	1.047
COh	Open	147	1.102
EOh	Open	499	1.203
1Fh	0	Open	1.352
3Fh	21.5	Open	1.500
5Fh	34.8	Open	1.797
7Fh	52.3	Open	2.500
9Fh	75	Open	3.000
BFh	105	Open	3.297
DFh	147	Open	5.000
FFh	499	Open	0.000

# TABLE 4. PROG 2 RESISTOR READER EXAMPLE

PROG2 (DD)	R <sub>UP</sub> (kΩ)	R <sub>DW</sub> (kΩ)	PWM/PFM	TEMP COMP	PM_ADDR (7-BIT)
00h	Open	0	Enabled	30	60h
20h	Open	21.5	Enabled	15	60h
40h	Open	34.8	Enabled	5	60h
60h	Open	52.3	Enabled	OFF	60h
80h	Open	75	Disabled	30	60h
A0h	Open	105	Disabled	15	60h
C0h	Open	147	Disabled	5	60h
E0h	Open	499	Disabled	OFF	60h
1Fh	0	Open	Enabled	30	7F
3Fh	21.5	Open	Enabled	15	7F
5Fh	34.8	Open	Enabled	5	7F
7Fh	52.3	Open	Enabled	OFF	7F
9Fh	75	Open	Disabled	30	7F
BFh	105	Open	Disabled	15	7F
DFh	147	Open	Disabled	5	7F
FFh	499	Open	Disabled	OFF	7F

## TABLE 5. PROG 3 RESISTOR READER EXAMPLE

PROG3	ROG3 R <sub>UP</sub> R <sub>DW</sub> UL			RASONIC FAULT	fsw	R4 GAIN	
(DE)	(kΩ)	(kΩ)	PFM	BEHAVIOR	(kHz)	1x	2x
00h	Open	0	Disabled	Retry	300	42	84
20h	Open	21.5	Disabled	Retry	700	42	84
40h	Open	34.8	Disabled	Latch	300	42	84
60h	Open	52.3	Disabled	Latch	700	42	84
80h	Open	75	Enabled	Retry	300	42	84
A0h	Open	105	Enabled	Retry	700	42	84
COh	Open	147	Enabled	Latch	300	42	84
E0h	Open	499	Enabled	Latch	700	42	84
1Fh	0	Open	Disabled	Retry	600	1	2
3Fh	21.5	Open	Disabled	Retry	1500	1	2
5Fh	34.8	Open	Disabled	Latch	600	1	2
7Fh	52.3	Open	Disabled	Latch	1500	1	2
9Fh	75	Open	Enabled	Retry	600	1	2
BFh	105	Open	Enabled	Retry	1500	1	2
DFh	147	Open	Enabled	Latch	600	1	2
FFh	499	Open	Enabled	Latch	1500	1	2

## TABLE 6. PROG 4 RESISTOR READER EXAMPLE

			TEORETON TEAD		
PROG4 (DF	R <sub>UP</sub> (kΩ)	R <sub>DW</sub> (kΩ)	SS RATE (mV/µs)	RR (kΩ)	AVMLTI
00h	Open	0	1.25	200	1x
20h	Open	21.5	2.5	200	<b>1</b> x
40h	Open	34.8	5	200	<b>1</b> x
60h	Open	52.3	10	200	<b>1</b> x
80h	Open	75	0.078	200	<b>1</b> x
A0h	Open	105	0.157	200	<b>1</b> x
COh	Open	147	0.315	200	<b>1</b> x
E0h	Open	499	0.625	200	<b>1</b> x
1Fh	0	Open	1.25	800	2x
3Fh	21.5	Open	2.5	800	2x
5Fh	34.8	Open	5	800	2x
7Fh	52.3	Open	10	800	2x
9Fh	75	Open	0.078	800	2x
BFh	105	Open	0.157	800	2x
DFh	147	Open	0.315	800	2x
FFh	499	Open	0.625	800	2x



# **Soft-Start**

The ISL68201-based regulator has four periods during soft-start, as shown in Figure 7 on page 12. When the EN pin reaches above its enable threshold, after a 5.5ms timeout (worst case = 6.5ms) of bias supplies, the controller begins the first soft-start ramp after a fixed soft-start delay period  $t_{D1}$  as shown in Figures 21 and 22 on page 22. The output voltage reaches the boot-up voltage (VBOOT) at a fixed slew rate in period  $t_{D2}$ . Then, the controller regulates the output voltage at VBOOT for another period  $t_{D3}$  until SMBus/PMBus/  $I^2C$  sends a new VOUT command. If the VOUT command is valid, the ISL68201 initiates the ramp until the voltage reaches the new VOUT\_COMMAND voltage in period  $t_{D4}$ . The soft-start time is the sum of the four periods, as shown in Equation 1.

$$t_{SS} = t_{D1} + t_{D2} + t_{D3} + t_{D4}$$
 (EQ. 1)

 $t_{D1}$  is a fixed delay with a typical value of 200 $\mu$ s.  $t_{D3}$  is determined by the time to obtain a new valid VOUT\_COMMAND voltage from SMBus/PMBus/I<sup>2</sup>C bus. If the VOUT\_COMMAND is valid before the output reaches the boot-up voltage, the output turns around to respond to the new VOUT\_COMMAND code.

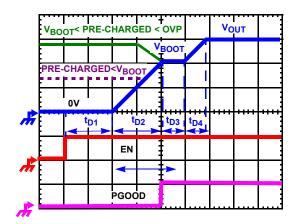


FIGURE 7. SOFT-START WAVEFORMS

During  $t_{D2}$  and  $t_{D4}$ , the ISL68201 digitally controls the DAC voltage change. The ramp time  $t_{D2}$  and  $t_{D4}$  can be calculated based on Equations 2 and 3, after the slew rate is set by the PROG4 pin.

$$t_{D2} = \frac{V_{BOOT}}{RAMP\_RATE}(\mu s)$$
 (EQ. 2)

$$t_{D4} = \frac{V_{OUT} - V_{BOOT}}{RAMP RATE}(\mu s)$$
 (EQ. 3)

The ISL68201 supports precharged start-up, which initiates the first PWM pulse until the internal reference (DAC) reaches the precharged level at RAMP\_RATE, programmed by PROG4 or D5[2:0]. When the precharged level is below  $V_{BOOT}$ , the output walks up to the  $V_{BOOT}$  at RAMP\_RATE and releases PGOOD at  $t_{D1} + t_{D2}.$  When the precharged output is above  $V_{BOOT}$  but below OVP, it walks down to  $V_{BOOT}$  at RAMP\_RATE and then releases PGOOD at  $t_{D1} + t_{D2},$  in which  $t_{D2}$  is defined in Equation 4 and is longer than a normal start-up.

$$t_{D2} = \frac{V_{PRECHARGED}}{RAMP\_RATE} + \frac{V_{PRECHARGED} - V_{BOOT}}{RAMP\_RATE} (\mu s)$$
 (EQ. 4)

The ISL68201 supports precharged load start-up to the maximum  $V_{OUT}$  of 5.5V with sufficient boot capacitor charge. For an extended precharged load, the boot capacitor discharges to "PVCC -  $V_{OUT}$  -  $V_D$ " by the high-side drive circuits' standby current. For instance, during an extended 4V precharged load, the boot capacitor reduces to a less-than-1V boot capacitor voltage, which is insufficient to power up the VR; in this case, it is recommended to let the output drop below 2.5V with an external bleed resistor before issuing another soft-start command.

## **Boot-Up Voltage Programming**

An 8-bit pin PROG1 is dedicated for the boot-up voltage programmability, which offers 256 options OV and 0.5V to 5.5V, as in <u>Table 7</u>. The most popular boot-up voltage levels are placed on the tie-low spots (0h, 20h, 40h, 60h, 80h, A0h, C0h, E0h) and the tie-high spots (1Fh, 3Fh, 5Fh, 7Fh, 9Fh, BFh, DFh, FFh) for easy programming, as summarized in <u>Table 3</u>. A OV boot-up voltage is considered as "OFF," the driver is in tri-state and the internal DAC sets to OV.

In addition, if the VOUT\_COMMAND (21h) is executed successfully 5.5ms (typically, worst 6.5ms) after VCC POR and before Enable, it overrides the boot-up voltage set by the PROG1 pin.

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE)

BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)
00000000	0	0.7969	66	
0000001	1	0.5000	40	
00000010	2	0.5078	41	7.8125
00000011	3	0.5156	42	7.8125
00000100	4	0.5234	43	7.8125
00000101	5	0.5313	44	7.8125
00000110	6	0.5391	45	7.8125
00000111	7	0.5469	46	7.8125
00001000	8	0.5547	47	7.8125
00001001	9	0.5625	48	7.8125
00001010	Α	0.5703	49	7.8125
00001011	В	0.5781	4A	7.8125
00001100	С	0.5859	4B	7.8125
00001101	D	0.5938	4C	7.8125
00001110	Е	0.6016	4D	7.8125
00001111	F	0.6094	4E	7.8125
00010000	10	0.6172	4F	7.8125
00010001	11	0.6250	50	7.8125
00010010	12	0.6328	51	7.8125



TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)					
BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)	
00010011	13	0.6406	52	7.8125	
00010100	14	0.6484	53	7.8125	
00010101	15	0.6563	54	7.8125	
00010110	16	0.6641	55	7.8125	
00010111	17	0.6719	56	7.8125	
00011000	18	0.6797	57	7.8125	
00011001	19	0.6875	58	7.8125	
00011010	1A	0.6953	59	7.8125	
00011011	1B	0.7031	5A	7.8125	
00011100	1C	0.7109	5B	7.8125	
00011101	1D	0.7188	5C	7.8125	
00011110	1E	0.7266	5D	7.8125	
00011111	1F	1.3516	AD		
00100000	20	0.8516	6D		
00100001	21	0.7344	5E	7.8125	
00100010	22	0.7422	5F	7.8125	
00100011	23	0.7500	60	7.8125	
00100100	24	0.7578	61	7.8125	
00100101	25	0.7656	62	7.8125	
00100110	26	0.7734	63	7.8125	
00100111	27	0.7813	64	7.8125	
00101000	28	0.7891	65	7.8125	
00101001	29	0.7969	66	7.8125	
00101010	2A	0.8047	67	7.8125	
00101011	2B	0.8125	68	7.8125	
00101100	2C	0.8203	69	7.8125	
00101101	2D	0.8281	6A	7.8125	
00101110	2E	0.8359	6B	7.8125	
00101111	2F	0.8438	6C	7.8125	
00110000	30	0.8516	6D	7.8125	
00110001	31	0.8594	6E	7.8125	
00110010	32	0.8672	6F	7.8125	
00110011	33	0.8750	70	7.8125	
00110100	34	0.8828	71	7.8125	
00110101	35	0.8906	72	7.8125	
00110110	36	0.8984	73	7.8125	
00110111	37	0.9063	74	7.8125	
00111000	38	0.9141	75	7.8125	
00111001	39	0.9219	76	7.8125	

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)

BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)
00111010	ЗА	0.9297	77	7.8125
00111011	3B	0.9375	78	7.8125
00111100	3C	0.9453	79	7.8125
00111101	3D	0.9531	7A	7.8125
00111110	3E	0.9609	7B	7.8125
00111111	3F	1.5000	СО	
01000000	40	0.8984	73	
01000001	41	0.9688	7C	7.8125
01000010	42	0.9766	7D	7.8125
01000011	43	0.9844	7E	7.8125
01000100	44	0.9922	7F	7.8125
01000101	45	1.0000	80	7.8125
01000110	46	1.0078	81	7.8125
01000111	47	1.0156	82	7.8125
01001000	48	1.0234	83	7.8125
01001001	49	1.0313	84	7.8125
01001010	4A	1.0391	85	7.8125
01001011	4B	1.0469	86	7.8125
01001100	4C	1.0547	87	7.8125
01001101	4D	1.0625	88	7.8125
01001110	4E	1.0703	89	7.8125
01001111	4F	1.0781	8A	7.8125
01010000	50	1.0859	8B	7.8125
01010001	51	1.0938	8C	7.8125
01010010	52	1.1016	8D	7.8125
01010011	53	1.1094	8E	7.8125
01010100	54	1.1172	8F	7.8125
01010101	55	1.1250	90	7.8125
01010110	56	1.1328	91	7.8125
01010111	57	1.1406	92	7.8125
01011000	58	1.1484	93	7.8125
01011001	59	1.1563	94	7.8125
01011010	5A	1.1641	95	7.8125
01011011	5B	1.1719	96	7.8125
01011100	5C	1.1797	97	7.8125
01011101	5D	1.1875	98	7.8125
01011110	5E	1.1953	99	7.8125
01011111	5F	1.7969	E6	
01100000	60	0.9531	7A	



TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)					
BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)	
01100001	61	1.2031	9A	7.8125	
01100010	62	1.2109	9В	7.8125	
01100011	63	1.2188	9C	7.8125	
01100100	64	1.2266	9D	7.8125	
01100101	65	1.2344	9E	7.8125	
01100110	66	1.2422	9F	7.8125	
01100111	67	1.2500	A0	7.8125	
01101000	68	1.2578	A1	7.8125	
01101001	69	1.2656	A2	7.8125	
01101010	6A	1.2734	А3	7.8125	
01101011	6B	1.2813	A4	7.8125	
01101100	6C	1.2891	A5	7.8125	
01101101	6D	1.2969	A6	7.8125	
01101110	6E	1.3047	Α7	7.8125	
01101111	6F	1.3125	A8	7.8125	
01110000	70	1.3203	А9	7.8125	
01110001	71	1.3281	AA	7.8125	
01110010	72	1.3359	AB	7.8125	
01110011	73	1.3438	AC	7.8125	
01110100	74	1.3516	AD	7.8125	
01110101	75	1.3594	AE	7.8125	
01110110	76	1.3672	AF	7.8125	
01110111	77	1.3750	В0	7.8125	
01111000	78	1.3828	B1	7.8125	
01111001	79	1.3906	B2	7.8125	
01111010	7A	1.3984	В3	7.8125	
01111011	7B	1.4063	В4	7.8125	
01111100	7C	1.4141	B5	7.8125	
01111101	7D	1.4219	В6	7.8125	
01111110	7E	1.4297	В7	7.8125	
0111111	7F	2.5000	140		
10000000	80	1.0000	80		
10000001	81	1.4375	В8	7.8125	
10000010	82	1.4453	В9	7.8125	
10000011	83	1.4531	ВА	7.8125	
10000100	84	1.4609	ВВ	7.8125	
10000101	85	1.4688	ВС	7.8125	
10000110	86	1.4766	BD	7.8125	

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)

BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)
10001000	88	1.4922	BF	7.8125
10001001	89	1.5000	со	7.8125
10001010	8A	1.5078	C1	7.8125
10001011	8B	1.5156	C2	7.8125
10001100	8C	1.5234	С3	7.8125
10001101	8D	1.5313	C4	7.8125
10001110	8E	1.5391	C5	7.8125
10001111	8F	1.5469	C6	7.8125
10010000	90	1.5547	C7	7.8125
10010001	91	1.5625	C8	7.8125
10010010	92	1.5703	C9	7.8125
10010011	93	1.5781	CA	7.8125
10010100	94	1.5859	СВ	7.8125
10010101	95	1.5938	СС	7.8125
10010110	96	1.6016	CD	7.8125
10010111	97	1.6094	CE	7.8125
10011000	98	1.6172	CF	7.8125
10011001	99	1.6250	D0	7.8125
10011010	9A	1.6328	D1	7.8125
10011011	9B	1.6406	D2	7.8125
10011100	9C	1.6484	D3	7.8125
10011101	9D	1.6563	D4	7.8125
10011110	9E	1.6641	D5	7.8125
10011111	9F	3.0000	180	
10100000	A0	1.0469	86	
10100001	A1	1.6719	D6	7.8125
10100010	A2	1.6797	D7	7.8125
10100011	А3	1.6875	D8	7.8125
10100100	A4	1.6953	D9	7.8125
10100101	A5	1.7031	DA	7.8125
10100110	A6	1.7109	DB	7.8125
10100111	A7	1.7188	DC	7.8125
10101000	A8	1.7266	DD	7.8125
10101001	A9	1.7344	DE	7.8125
10101010	AA	1.7422	DF	7.8125
10101011	АВ	1.7500	EO	7.8125
10101100	AC	1.7578	E1	7.8125
10101101	AD	1.7656	E2	7.8125
10101110	AE	1.7734	E3	7.8125



7.8125

ΒE

87

1.4844

10000111

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)					
BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)	
10101111	AF	1.7813	E4	7.8125	
10110000	во	1.7891	E5	7.8125	
10110001	B1	1.7969	E6	7.8125	
10110010	B2	1.8047	E7	7.8125	
10110011	В3	1.8125	E8	7.8125	
10110100	B4	1.8203	E9	7.8125	
10110101	B5	1.8281	EA	7.8125	
10110110	В6	1.8359	EB	7.8125	
10110111	В7	1.9141	F5	78.125	
10111000	В8	1.9922	FF	78.125	
10111001	В9	2.0703	109	78.125	
10111010	ВА	2.1484	113	78.125	
10111011	ВВ	2.2266	11D	78.125	
10111100	ВС	2.3047	127	78.125	
10111101	BD	2.3828	131	78.125	
10111110	BE	2.4609	13B	78.125	
10111111	BF	3.2969	<b>1</b> A6		
11000000	СО	1.1016	8D		
11000001	C1	2.4688	13C	7.8125	
11000010	C2	2.4766	13D	7.8125	
11000011	С3	2.4844	13E	7.8125	
11000100	C4	2.4922	13F	7.8125	
11000101	C5	2.5000	140	7.8125	
11000110	C6	2.5078	141	7.8125	
11000111	C7	2.5156	142	7.8125	
11001000	C8	2.5234	143	7.8125	
11001001	С9	2.6016	14D	78.125	
11001010	CA	2.6797	157	78.125	
11001011	СВ	2.7578	161	78.125	
11001100	СС	2.8359	16B	78.125	
11001101	CD	2.9141	175	78.125	
11001110	CE	2.9922	17F	78.125	
11001111	CF	3.0703	189	78.125	
11010000	DO	3.1484	193	78.125	
11010001	D1	3.2266	19D	78.125	
11010010	D2	3.2813	1A4	54.6875	
11010011	D3	3.2891	1A5	7.8125	
11010100	D4	3.2969	1A6	7.8125	

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)

11010110         D6         3.3125         1A8         7.8125           11010111         D7         3.3203         1A9         7.8125           11011000         D8         3.3281         1AA         7.8125           1101101         D9         3.4063         1B4         78.125           1101101         DA         3.4844         1BE         78.125           1101101         DB         3.5625         1C8         78.125           1101110         DC         3.6406         1D2         78.125           1101111         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100010         E3         4.0313         204         78.125           11100101         E5         4.1875         218         78.125           11100101         E5         4.1875         218         78.125           11100111         E7         4.3438         <	BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)
11011000         D8         3.3281         1AA         7.8125           11011001         D9         3.4063         1B4         78.125           11011010         DA         3.4844         1BE         78.125           11011011         DB         3.5625         1C8         78.125           11011100         DC         3.6406         1D2         78.125           11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           1110010         E4         4.1094         20E         78.125           1110010         E4         4.1094         20E         78.125           1110010         E6         4.2656         222         78.125           1110010         E6         4.2656         222         78.125           11101010         E8         4.4219         236         78.125           11101010         EA         4.5781	11010110	D6	3.3125	1A8	7.8125
11011001         D9         3.4063         1B4         78.125           11011010         DA         3.4844         1BE         78.125           11011011         DB         3.5625         1C8         78.125           11011100         DC         3.6406         1D2         78.125           11011101         DD         3.7188         1DC         78.125           11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100001         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100101         E3         4.0313         204         78.125           11100101         E3         4.1875         218         78.125           11100101         E4         4.1094         20E         78.125           11100101         E6         4.2656         222         78.125           11100101         E6         4.2656         222         78.125           11101010         EA         4.5781	11010111	D7	3.3203	1A9	7.8125
11011010         DA         3.4844         1BE         78.125           11011011         DB         3.5625         1C8         78.125           11011100         DC         3.6406         1D2         78.125           11011101         DD         3.7188         1DC         78.125           11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100001         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100101         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E6         4.2656         222         78.125           11100110         E6         4.2656         222         78.125           11101001         E8         4.4219         236         78.125           11101001         EA         4.5781         24A         78.125           11101001         EA         4.5781	11011000	D8	3.3281	1AA	7.8125
11011011         DB         3.5625         1C8         78.125           11011100         DC         3.6406         1D2         78.125           11011101         DD         3.7488         1DC         78.125           11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100011         E3         4.0313         204         78.125           11100101         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11101001         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101011         EB         4.6563         254         78.125           11101010         EC         4.7344	11011001	D9	3.4063	1B4	78.125
11011100         DC         3.6406         1D2         78.125           11011101         DD         3.7188         1DC         78.125           11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100011         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100101         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101001         EA         4.5781         24A         78.125           11101101         EB         4.6563         254         78.125           11101101         EB         4.8966	11011010	DA	3.4844	1BE	78.125
11011101         DD         3.7188         1DC         78.125           11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100011         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100101         E6         4.2656         222         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101101         EB         4.8663         254         78.125           11101111         EF         4.9688	11011011	DB	3.5625	108	78.125
11011110         DE         3.7969         1E6         78.125           11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100101         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100101         E6         4.2656         222         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906	11011100	DC	3.6406	1D2	78.125
11011111         DF         5.0000         280           11100000         E0         1.2031         9A           11100010         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100101         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101101         EB         4.6563         254         78.125           11101101         ED         4.8125         268         78.125           11101111         EF         4.9688	11011101	DD	3.7188	1DC	78.125
11100000         E0         1.2031         9A           11100001         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100101         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           1110101         EA         4.5781         24A         78.125           1110101         EB         4.6563         254         78.125           1110110         EC         4.7344         25E         78.125           11101101         ED         4.8125         268         78.125           11101111         EF         4.9688         27C         78.125           11110000         F0	11011110	DE	3.7969	1E6	78.125
11100001         E1         3.8750         1F0         78.125           11100010         E2         3.9531         1FA         78.125           11100011         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100110         E6         4.2656         222         78.125           11100101         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101101         EB         4.6563         254         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906         272         78.125           11110000	11011111	DF	5.0000	280	
11100010         E2         3.9531         1FA         78.125           11100011         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101100         EC         4.7344         25E         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906         272         78.125           11100111         EF         4.9688         27C         78.125           11110000         F0         4.9766         27D         7.8125           11110001	11100000	EO	1.2031	9A	
11100011         E3         4.0313         204         78.125           11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101100         EC         4.7344         25E         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906         272         78.125           11100111         EF         4.9688         27C         78.125           11110000         F0         4.9766         27D         7.8125           11110010         F2         4.9922         27F         7.8125           11110011	11100001	E1	3.8750	1F0	78.125
11100100         E4         4.1094         20E         78.125           11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101100         EC         4.7344         25E         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906         272         78.125           11101111         EF         4.9688         27C         78.125           11110000         F0         4.9766         27D         7.8125           11110001         F1         4.9844         27E         7.8125           11110010         F2         4.9922         27F         7.8125           11110010	11100010	E2	3.9531	1FA	78.125
11100101         E5         4.1875         218         78.125           11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101100         EC         4.7344         25E         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906         272         78.125           11101111         EF         4.9688         27C         78.125           11110000         F0         4.9766         27D         7.8125           11110001         F1         4.9844         27E         7.8125           11110010         F2         4.9922         27F         7.8125           11110010         F4         5.0078         281         7.8125           11110101	11100011	E3	4.0313	204	78.125
11100110         E6         4.2656         222         78.125           11100111         E7         4.3438         22C         78.125           11101000         E8         4.4219         236         78.125           11101001         E9         4.5000         240         78.125           11101010         EA         4.5781         24A         78.125           11101011         EB         4.6563         254         78.125           11101100         EC         4.7344         25E         78.125           11101101         ED         4.8125         268         78.125           11101110         EE         4.8906         272         78.125           11101111         EF         4.9688         27C         78.125           11110000         F0         4.9766         27D         7.8125           11110001         F1         4.9844         27E         7.8125           11110010         F2         4.9922         27F         7.8125           11110011         F3         5.0000         280         7.8125           11110101         F5         5.0156         282         7.8125           11110110	11100100	E4	4.1094	20E	78.125
11100111       E7       4.3438       22C       78.125         11101000       E8       4.4219       236       78.125         11101001       E9       4.5000       240       78.125         11101010       EA       4.5781       24A       78.125         11101011       EB       4.6563       254       78.125         11101100       EC       4.7344       25E       78.125         11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110010       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8	11100101	E5	4.1875	218	78.125
11101000       E8       4.4219       236       78.125         11101001       E9       4.5000       240       78.125         11101010       EA       4.5781       24A       78.125         11101011       EB       4.6563       254       78.125         11101100       EC       4.7344       25E       78.125         11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110010       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11110001       F8       5.1094       28E       78.125         11111001       FA	11100110	E6	4.2656	222	78.125
11101001       E9       4.5000       240       78.125         11101010       EA       4.5781       24A       78.125         11101011       EB       4.6563       254       78.125         11101100       EC       4.7344       25E       78.125         11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110010       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111001       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111011       FB	11100111	E7	4.3438	22C	78.125
11101010       EA       4.5781       24A       78.125         11101011       EB       4.6563       254       78.125         11101100       EC       4.7344       25E       78.125         11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       FO       4.9766       27D       7.8125         11110010       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111011       FB       5.3438       2AC       78.125	11101000	E8	4.4219	236	78.125
11101011       EB       4.6563       254       78.125         11101100       EC       4.7344       25E       78.125         11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111011       FB       5.3438       2AC       78.125	11101001	E9	4.5000	240	78.125
11101100       EC       4.7344       25E       78.125         11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111011       FB       5.3438       2AC       78.125	11101010	EA	4.5781	24A	78.125
11101101       ED       4.8125       268       78.125         11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11101011	EB	4.6563	254	78.125
11101110       EE       4.8906       272       78.125         11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111011       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11101100	EC	4.7344	25E	78.125
11101111       EF       4.9688       27C       78.125         11110000       F0       4.9766       27D       7.8125         11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11101101	ED	4.8125	268	78.125
11110000       F0       4.9766       27D       7.8125         11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111011       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11101110	EE	4.8906	272	78.125
11110001       F1       4.9844       27E       7.8125         11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11101111	EF	4.9688	27C	78.125
11110010       F2       4.9922       27F       7.8125         11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11110000	F0	4.9766	27D	7.8125
11110011       F3       5.0000       280       7.8125         11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11110001	F1	4.9844	27E	7.8125
11110100       F4       5.0078       281       7.8125         11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11110010	F2	4.9922	27F	7.8125
11110101       F5       5.0156       282       7.8125         11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11110011	F3	5.0000	280	7.8125
11110110       F6       5.0234       283       7.8125         11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11110100	F4	5.0078	281	7.8125
11110111       F7       5.0313       284       7.8125         11111000       F8       5.1094       28E       78.125         11111001       F9       5.1875       298       78.125         11111010       FA       5.2656       2A2       78.125         11111011       FB       5.3438       2AC       78.125	11110101	F5	5.0156	282	7.8125
11111000     F8     5.1094     28E     78.125       11111001     F9     5.1875     298     78.125       11111010     FA     5.2656     2A2     78.125       11111011     FB     5.3438     2AC     78.125	11110110	F6	5.0234	283	7.8125
11111001     F9     5.1875     298     78.125       11111010     FA     5.2656     2A2     78.125       11111011     FB     5.3438     2AC     78.125	11110111	F7	5.0313	284	7.8125
11111010     FA     5.2656     2A2     78.125       11111011     FB     5.3438     2AC     78.125	11111000	F8	5.1094	28E	78.125
11111011 FB 5.3438 2AC 78.125	11111001	F9	5.1875	298	78.125
	11111010	FA	5.2656	2A2	78.125
11111100 FC 5.4219 2B6 78 125	11111011	FB	5.3438	2AC	78.125
	11111100	FC	5.4219	2B6	78.125



7.8125

D5

3.3047

**1**A7

11010101

TABLE 7. PROG1 8-BIT (BOOT-UP VOLTAGE) (Continued)

BINARY CODE	HEX CODE	V <sub>BOOT</sub> (V)	VOUT COMMAND CODE (HEX)	DELTA FROM PREVIOUS CODE (mV)
11111101	FD	5.4922	2BF	70.3125
11111110	FE	5.5000	200	7.8125
11111111	FF	0	0	

As shown in <u>Table 7</u>, one step is  $2^{-7}$  = 7.8125mV; some selections are higher than one step from adjacent codes. However, the resolution is  $\pm 7.8125$ mV around the popular voltage regulation points, as in <u>Table 3 on page 11</u>, for fine-tuning purposes. For finer than 7.8125mV tuning, place a large ratio resistor divider on the VSEN pin between the output (V<sub>OUT</sub>) and RGND for positive offset or V<sub>CC</sub> for negative offset, as shown in <u>Figure 8</u>.

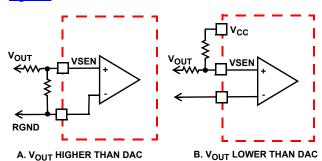


FIGURE 8. EXTERNAL PROGRAMMABLE REGULATION

## **Current Sensing**

The ISL68201 supports inductor DCR sensing, or resistive sensing techniques, and senses current continuously for fast response. The current sense amplifier uses the CSEN and CSRTN inputs to reproduce a signal proportional to the inductor current,  $I_L.$  The sense current,  $I_{SEN}$ , is proportional to the inductor current and is used for current reporting and overcurrent protection.

The input bias current of the current sensing amplifier is typically 10s of nA. Less than 15k $\Omega$  input impedance connected to CSEN pin is preferred to minimize the offset error, that is, use a larger C value (select 0.22 $\mu$ F to 1 $\mu$ F instead of 0.1 $\mu$ F when needed). In addition, the current sensing gain resistor connected to CSRTN pin should be within 40 $\Omega$  to 3.5k $\Omega$ .

## **INDUCTOR DCR SENSING**

An inductor's winding is characteristic of a distributed resistance, as measured by the Direct Current Resistance (DCR) parameter. A simple R-C network across the inductor extracts the DCR voltage, as shown in Figure 9.

The voltage on the capacitor  $V_C$ , can be shown to be proportional to the inductor current  $I_{L_{\,\,{}}}$  as in Equation 5.

$$V_{C}(s) = \frac{\left(s \cdot \frac{L}{DCR} + 1\right) \cdot (DCR \cdot I_{L})}{(s \cdot RC + 1)}$$
(EQ. 5)

If the R-C network components are selected so that the R-C time constant (= R\*C) matches the inductor time constant (= L/DCR), the voltage across the capacitor  $V_C$  is equal to the voltage drop

across the DCR. With the internal low-offset current amplifier, the capacitor voltage  $V_{C}$  is replicated across the sense resistor  $R_{\rm ISEN}$ . Therefore, the current out of the CSRTN pin,  $I_{\rm SEN}$ , is proportional to the inductor current.

Equation 6 shows that the ratio of the inductor current to the sensed current,  $I_{SEN}$ , is driven by the value of the sense resistor and the DCR of the inductor.

$$I_{SEN} = I_L \cdot \frac{DCR}{R_{ISEN}}$$
 (EQ. 6)

The inductor DCR value increases as the temperature increases. Therefore, the sensed current increases as the temperature of the current sense element increases. To compensate for the temperature effect on the sensed current signal, the integrated temperature compensation function of the ISL68201 should be used. The integrated temperature compensation function is described in "Thermal Monitoring and Compensation" on page 18.

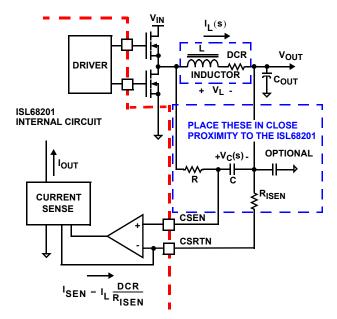


FIGURE 9. DCR SENSING CONFIGURATION

#### **RESISTIVE SENSING**

For accurate current sense, a dedicated current-sense resistor, R<sub>SENSE</sub>, in series with each output inductor, can serve as the current sense element (see <u>Figure 10</u>). This technique, however, reduces overall converter efficiency due to the additional power loss on the current sense element R<sub>SENSE</sub>.



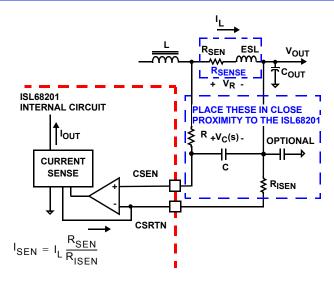


FIGURE 10. SENSE RESISTOR IN SERIES WITH INDUCTORS

A current sensing resistor has a distributed parasitic inductance, known as Equivalent Series Inductance (ESL) parameter, typically less than 1nH. A simple R-C network across the current-sense resistor extracts the R<sub>SEN</sub> voltage, as shown in Figure 10 on page 17.

The voltage on the capacitor  $V_C$ , can be shown to be proportional to the inductor current  $I_L$ , see Equation 7.

$$V_{C}(s) = \frac{\left(s \cdot \frac{ESL}{R_{SEN}} + 1\right) \cdot (R_{SEN} \cdot I_{L})}{(s \cdot RC + 1)}$$
 (EQ. 7)

If the R-C network components are selected so that the RC time constant matches the ESL-R<sub>SEN</sub> time constant (R\*C = ESL/R<sub>SEN</sub>), the voltage across the capacitor V<sub>C</sub> is equal to the voltage drop across the R<sub>SEN</sub>, that is, proportional to the inductor current. As an example, a typical 1m $\Omega$  sense resistor can use R = 348 $\Omega$  and C = 820pF for the matching. Figures 11 and 12 show the sensed waveforms without and with matching RC when using resistive sense.



FIGURE 12. VOLTAGE ACROSS C WITH MATCHING RC

$$I_{SEN} = I_L \cdot \frac{R_{SEN}}{R_{ISEN}}$$
 (EQ. 8)

## L/DCR OR ESL/R<sub>SEN</sub> MATCHING

Figure 13 shows the expected load transient response waveforms if L/DCR or ESL/R<sub>SEN</sub> is matching the R-C time constant. When the load current has a square change, the IOUT pin voltage ( $V_{IOUT}$ ) without a decoupling capacitor also has a square response. However, there is always some PCB contact impedance of current sensing components between the two current sensing points; it hardly accounts into the L/DCR or ESL/R<sub>SEN</sub> matching calculation. Fine tuning the matching is done in the board level to improve overall transient performance and system reliability.

If the R-C timing constant is too large or too small,  $V_C(s)$  does not accurately represent real-time output current and worsens the overcurrent fault response. Figure 14 shows the IOUT pin transient voltage response when the R-C timing constant is too small.  $V_{IOUT}$  sags excessively upon load insertion and may create a system failure or early overcurrent trip. Figure 15 shows the transient response when the R-C timing constant is too large.  $V_{IOUT}$  is sluggish in reaching its final value. The excessive delay on current sensing does not provide a fast OCP response and reduces system reliability.

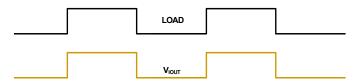


FIGURE 13. DESIRED LOAD TRANSIENT RESPONSE WAVEFORMS

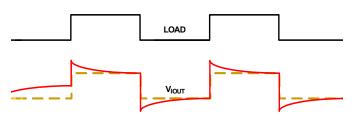


FIGURE 14. LOAD TRANSIENT RESPONSE WHEN R-C TIME CONSTANT IS TOO SMALL

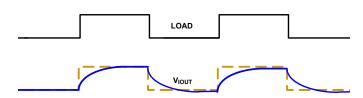


FIGURE 15. LOAD TRANSIENT RESPONSE WHEN R-C TIME CONSTANT IS TOO LARGE

Note that the integrated thermal compensation applies to the DC current, but not the AC current; therefore, the peak current seen by the controller increases as the temperature decreases and can potentially trigger an OCP event. To overcome this issue, the RC should be over-matching L/DCR at room temperature by  $(-40 \,^{\circ}\text{C} + 25 \,^{\circ}\text{C}) \,^{*}0.385\%/\,^{\circ}\text{C} = +25\%$  for  $-40 \,^{\circ}\text{C}$  operation.

# **Thermal Monitoring and Compensation**

The thermal monitoring function block diagram is shown in Figure 16 on page 18. One NTC resistor should be placed close to the respective power stage of the voltage regulator VR to sense the operational temperature, and pull-up resistors are needed to form the voltage dividers for the NTC pin. As the temperature of the power stage increases, the resistance of the NTC reduces, resulting in the reduced voltage at the NTC pin. Figure 18 on page 18 shows the TM voltage over the temperature for a typical design with a recommended 10k\O NTC (P/N: NCP15XH103J03RC from Murata,  $\beta$  = 3380) and 1.54k $\Omega$ resistor RTM. It is recommended to use those resistors for accurate temperature compensation because the internal thermal digital code is developed based on these two components. If a different value is used, the temperature coefficient must be close to 3380 and RTM must be scaled accordingly. For instance, if NTC =  $20k\Omega$  ( $\beta$  = 3380), then RTM should be  $20k\Omega/10k\Omega*1.54k\Omega = 3.08k\Omega$ .

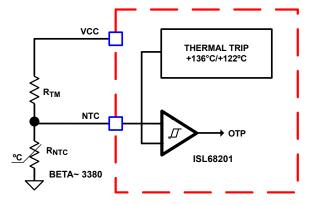


FIGURE 16. BLOCK DIAGRAM OF THERMAL MONITORING AND PROTECTION

The ISL68201 supports inductor DCR sensing, or resistive sensing techniques. The inductor DCR has a positive temperature coefficient, which is about +0.385%/°C. Because the voltage across the inductor is sensed for the output current information, the sensed current has the same positive temperature coefficient as the inductor DCR. To obtain the correct current information, the ISL68201 uses the voltage at the NTC pin and "TCOMP" register to compensate the temperature impact on the sensed current. The block diagram of this function is shown in Figure 17.

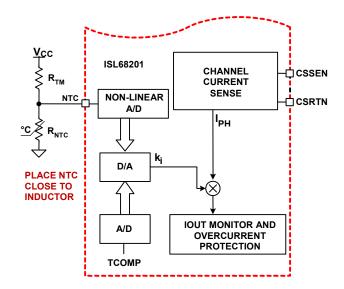


FIGURE 17. BLOCK DIAGRAM OF INTEGRATED TEMPERATURE COMPENSATION

When the NTC is placed close to the current sense component (inductor), the temperature of the NTC tracks the temperature of the current sense component. Therefore, the NTC pin voltage can be used to obtain the temperature of the current sense component. Because the NTC could pick up noise from phase node, a  $0.1\mu F$  ceramic decoupling capacitor is recommended on the NTC pin in close proximity to the controller.

Based on the  $V_{CC}$  voltage, the ISL68201 converts the NTC pin voltage to a digital signal for temperature compensation. With the nonlinear A/D converter of the ISL68201, the NTC digital signal is linearly proportional to the NTC temperature. For accurate temperature compensation, the ratio of the NTC voltage to the NTC temperature of the practical design should be similar to that in Figure 18.

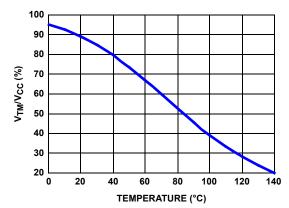


FIGURE 18. THE RATIO OF TM VOLTAGE TO NTC TEMPERATURE WITH RECOMMENDED PART

Because the NTC attaches to the PCB, but not directly to the current sensing component, it inherits high thermal impedance between the NTC and the current sensing element. The "TCOMP" register values can be used to correct the temperature difference between the NTC and the current sense component. As shown in Figure 19, the NTC should be placed in proximity to the output rail; DO NOT place it close to the MOSFET side, which generates much more heat.

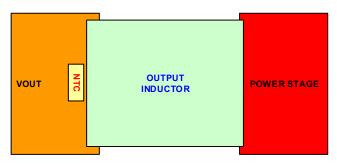


FIGURE 19. RECOMMENDED PLACEMENT OF NTC

The ISL68201 multiplexes the "TCOMP" value with the NTC digital signal to obtain the adjustment gain to compensate the temperature impact on the sensed channel current. The compensated current signal is used for I<sub>OUT</sub> and overcurrent protection functions. Use the TCOMP "OFF" code to disable thermal compensation when the current sensing element is the resistor or smart power stage (internally thermal compensated) that has little thermal drifting.

**TABLE 8. TCOMP VALUES** 

D1h	TCOMP (°C)	D1h	TCOMP (°C)
Oh	30	2h	5
<b>1</b> h	15	3h	OFF

The thermal compensation design procedure for inductor current sensing is summarized as follows:

- 1. Properly choose the voltage divider for the NTC pin to match the NTC voltage vs temperature curve with the recommended curve in Figure 18 on page 18.
- Operate the actual board under the full load and the desired airflow condition.
- After the board reaches the thermal steady state (often takes 15 minutes), record the temperature (T<sub>CSC</sub>) of the current sense component (inductor) and the voltage at NTC and VCC pins.
- 4. Use <u>Equation 9</u> to calculate the resistance of the NTC, and find out the corresponding NTC temperature  $T_{NTC}$  from the NTC datasheet or using <u>Equation 10</u>, where  $\beta$  is equal to 3380 for recommended NTC.

$$R_{NTC}(at T_{NTC}) = \frac{V_{TM}xR_{TM}}{V_{CC} - V_{TM}}$$
 (EQ. 9)

$$T_{NTC} = \frac{\beta}{\ln\left(\frac{R_{NTC}(at\ T_{NTC})}{R_{NTC}(at\ 25^{\circ}C)}\right) + \frac{\beta}{298.15}} - 273.15$$
 (EQ. 10)

Choose a number close to the result as in <u>Equation 11</u> for the "TCOMP" register.

$$T_{COMP} = T_{CSC} - T_{NTC}$$
 (EQ. 11)

- 6. Operate the actual board under full load again.
- Record the IOUT pin voltage as V1 immediately after the output voltage is stable with the full load. Record the IOUT pin voltage as V2 after the VR reaches the thermal steady state.
- 8. If the IOUT pin voltage increases over 10mV as the temperature increases (that is, V2 V1 > 10mV), reduce the "TCOMP" value. If the IOUT pin voltage decreases over 10mV as the temperature increases (that is, V1 V2 > 10mV), increase the "TCOMP" value. The "TCOMP" value can be adjusted through the serial bus for easy thermal compensation optimization.

# **I<sub>OUT</sub>** Calibration

The current flowing out of the IOUT pin is equal to the sensed average current inside ISL68201. A resistor is placed from the IOUT pin to GND to generate a voltage, which is proportional to the load current and the resistor value, as shown in Equation 12:

$$R_{IOUT} = \frac{2.5VxR_{ISEN}}{63.875AxR_x} = \frac{2.5Vx\left(\frac{R_xxI_{OCP}}{100\mu\text{A}}\right)}{63.875AxR_x}$$
$$= \frac{2.5VxI_{OCP}}{63.875Ax100\mu\text{A}} = \frac{25VxI_{OCP}}{63.875A} \text{ k}\Omega$$
 (EQ. 12)

where  $V_{IOUT}$  is the voltage at the IOUT pin,  $R_{IOUT}$  is the resistor between the IOUT pin and GND,  $I_{LOAD}$  is the total output current of the converter,  $R_{ISEN}$  is the sense resistor connected to the CSRTN pin, and  $R_X$  is the DC resistance of the current sense element, either the DCR of the inductor or  $R_{SENSE}$  depending on the sensing method. Scale the  $R_{IOUT}$  resistor to ensure that the voltage at the IOUT pin is typically 2.5V at 63.875A load current. The  $I_{OUT}$  voltage is linearly digitized every 108 $\mu$ s and stored in the READ\_IOUT register (8Ch).

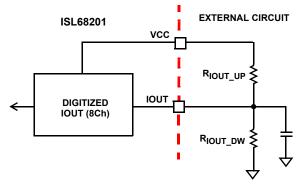


FIGURE 20. IOUT NO LOAD OFFSET CALIBRATION

Place a small capacitor between IOUT and GND to reduce the noise impact and provide averaging, > 200µs (typically).

To deal with layout and design variation of different platforms, the ISL68201 is intentionally trimmed to negative at no load, thus, an offset can easily be added to calibrate the digitized  $l_{OUT}$  reading (8Ch). Hence, the analog vs digitized current slope is set

by the equivalent impedance of  $R_{IOUT\_UP}/R_{IOUT\_DW} = R_{IOUT}$  (as in Figure 20); the slope of the ideal curve should set to 1A/A with OA offset.

For a precision digital  $I_{OUT}$ , follow the fine-tuned procedure below. Steps 1 to 5 must be completed before Step 6.

- Properly tune L/DCR or ESL/R<sub>SEN</sub> matching as shown on page 17 over the range of temperature operation. +25% over-matching L/DCR at room temperature is needed for -40°C operation.
- 2. Properly complete thermal compensation as shown in "Thermal Monitoring and Compensation" on page 18.
- Finalize the R<sub>ISEN</sub> resistor to set OCP for overall operating conditions and board variations as shown in <u>"Overcurrent and Short-Circuit Protection" on page 20</u>.
- Collect no load I<sub>OUT</sub> current with sufficient prototypes and determine the mean of no load I<sub>OUT</sub> current.
- 5. The pull-up impedance on IOUT pin should be "VCC/IOUT\_NO\_LOAD". For instance, a mean of -2.5 $\mu$ A I<sub>OUT</sub> at OA load needs R<sub>IOUT UP</sub> = 2M $\Omega$ .
- Start with the value below and then fine-tune the R<sub>IOUT\_DW</sub> value until the average slope of various boards equals 1A/A.

$$R_{IOUT\_DW} = \frac{R_{IOUT\_UP} \times R_{IOUT}}{R_{IOUT\_UP} - R_{IOUT}}$$
(EQ. 13)

#### **Fault Protection**

The ISL68201 provides high system reliability with many fault protections, as summarized in Table 9.

**TABLE 9. FAULT PROTECTION SUMMARY** 

FAULT	DESCRIPTION	FAULT ACTION	
Input UVLO	VIN pin UVLO; or set by EN pin with an external divider for a higher level. See Figures 4 and 5.	Shut down and recover when V <sub>IN</sub> > UVLO	
Bias UVLO	VCC, PVCC, 7VLDO UVLO	Shut down and recover when Bias > UVLO	
Start-Up OVP	Higher than V <sub>BOOT</sub> . See Electrical Specifications on page 7.	Latch OFF, reset by V <sub>CC</sub> or toggling enable	
Output OVP	Rising = 120%; Falling = 100%	(including EN pin and/ or OPERATION	
Output UVP	74% of V <sub>OUT</sub> , Latch OFF	command based on the ON_OFF_CONFIG setting)	
Output OCP	Average OCP = 100μA with 128μs blanking time.	Latch OFF (reset by V <sub>CC</sub> or toggling enable	
Short-Circuit Protection	Peak OCP = 130% of Average OCP with 50ns filter.	including EN pin and/ or OPERATION command based on the ON_OFF_CONFIG setting), or retry every 9ms; option is programmable by PROG3 or D3[0]	
ОТР	Rising = 22.31%VCC (~+136°C); Falling =27.79%VCC (~+122°C).	Shut down above +136°C and recover when temperature drops below +122°C	

The UVLO and OTP faults respond to the current state with hysteresis, output OVP and output UVP faults are latch events, and output OCP and output short-circuit faults can be latch or retry events depending upon the PROG3 or D3[0] setting. All fault latch events can be reset by VCC cycling, toggling the Enable pin and/or the serial bus OPERATION command based on the ON\_OFF\_CONFIG setting, while the OCP retry event has a hiccup time of 9ms and the regulator can be recovered when the fault is removed.

#### **OVERVOLTAGE PROTECTION**

The OVP fault detection circuit triggers after the voltage between VSEN+ and VSEN- is above the rising overvoltage threshold. When an OVP fault is declared, the controller latches off and the PGOOD pin asserts low. The fault remains latched and can be reset by  $V_{CC}$  cycling or toggling EN pin and/or the serial bus OPERATION command based on the ON\_OFF\_CONFIG setting.

Although the controller latches off in response to an OVP fault, the LGATE gate-driver output retains the ability to toggle the low-side MOSFET on and off, in response to the output voltage transversing the OVP rising and falling thresholds. The LGATE gate driver turns on the low-side MOSFET to discharge the output voltage, protecting the load. The LGATE gate driver turns off the low-side MOSFET when the sensed output voltage is lower than the falling overvoltage threshold (typically 100%). If the output voltage rises again, the LGATE driver turns on the low-side MOSFET again when the output voltage is above the rising overvoltage threshold (typically 120%). By doing so, the IC protects the load when there is a consistent overvoltage condition.

In addition to normal operation OVP, 5.5ms (typically, worst case = 6.5ms) after all rails (VCC, PVCC, 7VLDO, VIN) POR and before the end of soft-start, the start-up OVP circuits are enabled to protect against an OVP event, while the OVP level is set higher than  $V_{BOOT}$ . See Electrical Specifications on page 7.

#### **UNDERVOLTAGE PROTECTION**

The UVP fault detection circuit triggers when the output voltage is below the undervoltage threshold (typically 74% of DAC). When a UVP fault is declared, the controller latches off, forcing the LGATE and UGATE gate-driver outputs low, and the PGOOD pin asserts low. The fault remains latched and can be reset by  $\rm V_{CC}$  cycling or toggling the EN pin and/or the serial bus OPERATION command based on the ON\_OFF\_CONFIG setting.

## **OVERCURRENT AND SHORT-CIRCUIT PROTECTION**

The average Overcurrent Protection (OCP) is triggered when the internal current out of the IOUT pin goes above the fault threshold (typically  $100\mu A)$  with  $128\mu s$  blanking time. It also has a fast (50ns filter) secondary overcurrent protection whose threshold is +30% above average OCP. This protects inductor saturation from a short-circuit event and provides a more robust power train and system protection. When an OCP or short-circuit fault is declared, the controller latches off, forcing the LGATE and UGATE gate-driver outputs low, or retries with a hiccup time of 9ms. The fault response is programmable by PROG3 or D3[0]. However, the latched off event can be reset by  $V_{CC}$  cycling, toggling the EN pin, and/or the serial bus OPERATION command based on the ON\_OFF\_CONFIG setting.



Equation 14 provides a starting point to set a preliminary OCP trip point, in which IOCP is the targeted OCP trip point and DI (as in Equation 15) is the peak-to-peak inductor ripple current.

$$R_{ISEN1} = \frac{R_{x}xI_{OCP}}{100\mu A}$$

$$R_{ISEN2} = \frac{R_{x}x(\frac{\Delta I}{2} + I_{OCP})}{100\mu Ax(100\% + 30\%)}$$
(EQ. 14)

To deal with layout and PCB contact impedance variation, follow the fine-tuning procedure below for a more precise OCP. Steps 1 to 3 must be completed before Step 4.

- Properly tune L/DCR or ESL/R<sub>SEN</sub> matching as shown on page 17 over the range of temperature operation. +25% over-matching L/DCR at room temperature is needed for -40°C operation.
- Properly complete thermal compensation as shown in "Thermal Monitoring and Compensation" on page 18.
- Collect OCP trip points (IOCP\_MEASURED) with sufficient prototypes and determine the mean for overall operating conditions and board variations.
- Change R<sub>ISEN</sub> by IOCP\_TARGETED/IOCP\_MEASURED percentage to meet the targeted OCP.

Note that if the inductor peak-to-peak current is higher or closer to 30%, the +30% threshold could be triggered instead of the average OCP threshold. However, the fine-tuning procedure can still be used.

#### **OVER-TEMPERATURE PROTECTION**

As shown in Figure 16 on page 18, there is a comparator with hysteresis to compare the NTC pin voltage to the threshold set. When the NTC pin voltage is lower than 22.31% of the  $V_{CC}$  voltage (typically +136  $^{\circ}$ C), it triggers Over-Temperature Protection (OTP) and shuts down the ISL68201. When the NTC pin voltage is above 27.79% of the  $V_{CC}$  voltage (typically +122.4  $^{\circ}$ C), the ISL68201 resumes normal operation. When an OTP fault is declared, the controller forces the LGATE and UGATE gate-driver outputs low.

# **PGOOD Monitor**

The PGOOD pin indicates when the converter is capable of supplying regulated voltage. If there is a fault condition of a rail's (VCC, PVCC, 7VLDO, or VIN) UVLO, output Overcurrent (OCP), Overvoltage (OVP), Undervoltage (UVP), or Over-Temperature (OTP), PGOOD is asserted low. Note that the PGOOD pin is an undefined impedance with insufficient  $V_{CC}$  (typically <2.5V).

# **PFM Mode Operation**

In PFM mode, programmable by PROG2 or serial bus D0[0:0], the switching frequency is dramatically reduced to minimize the switching loss and significantly improve light-load efficiency. The ISL68201 can enter and exit PFM mode seamlessly as the load changes. The PFM mode is only compatible with the ISL99140 DrMOS with SMOD input by connecting to ISL68201's FCCM output pin. Incompatible power stages should operate in PWM mode.

# SMBus, PMBus, and I<sup>2</sup>C Operation

The ISL68201 features SMBus, PMBus, and I $^2$ C with 32 programmable addresses through the PROG2 pin, while SMBus/PMBus includes an Alert# line (SALERT) and Packet Error Check (PEC) to ensure data properly transmitted. The telemetry update rate is 108µs (typically). The supported SMBus/PMBus/I $^2$ C addresses are summarized in Table 10. The 7-bit format address does not include the last bit (write and read): 40-47h, 60-67h, and 70-7Fh.

SMBus/PMBus/I<sup>2</sup>C allows users to program the registers as in Table 11, except for SMBus/PMBus/I<sup>2</sup>C addresses, 5.5ms (typically, worst 6.5ms) after all rails (VCC, PVCC, 7VLDO, and VIN) above POR. Figures 21 and 22 show the initialization timing diagram for the serial bus with different states of the EN (Enable) pin.

For proper operation, users should follow the SMBus, PMBus, and  $I^2C$  protocol, as shown in <u>Figure 23 on page 23</u>. Note that the STOP (P) bit is NOT allowed before the repeated START condition when reading the contents of the register.

When the device's serial bus is not used, ground the device's SCL, SDA, and SALERT pins and do not connect them to the bus.

TABLE 10. SMBus/PMBus/I<sup>2</sup>C 7-BIT FORMAT ADDRESS (HEX)

7-BIT ADDRESS	7-BIT ADDRESS	7-BIT ADDRESS
40	63	76
41	64	77
42	65	78
43	66	79
44	67	7A
45	70	7B
46	71	7C
47	72	7D
60	73	7E
61	74	7F
62	75	

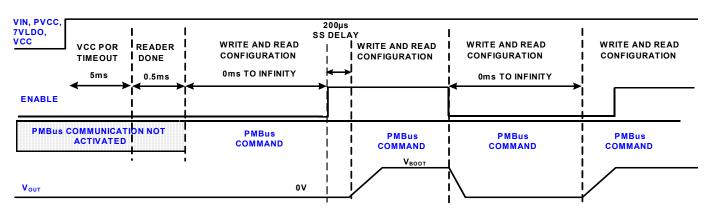


FIGURE 21. SIMPLIFIED SMBus/PMBus/I<sup>2</sup>C INITIALIZATION TIMING DIAGRAM WITH ENABLE LOW

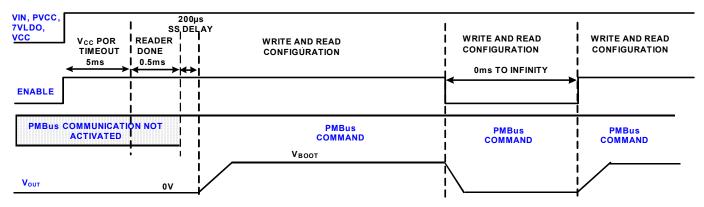
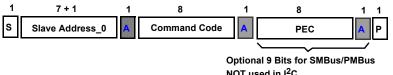


FIGURE 22. SIMPLIFIED SMBus/PMBus/I<sup>2</sup>C INITIALIZATION TIMING DIAGRAM WITH ENABLE HIGH

#### 1. Send Byte Protocol



NOT used in I<sup>2</sup>C

Example command: 03h Clear Faults

(This will clear all of the bits in Status Byte for the selected Rail)

S: Start Condition

A: Acknowledge ("0")

N: Not Acknowledge ("1")

W: Write ("0")

**RS: Repeated Start Condition** 

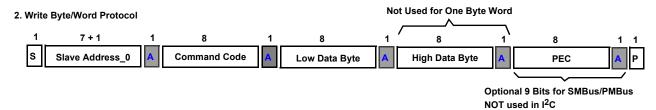
R: Read ("1")

**PEC: Packet Error Checking** 

P: Stop Condition

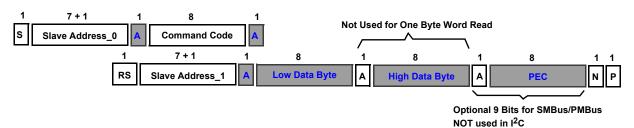
Acknowledge or DATA from Slave,

ISL68201



Example command: D0h ENABLE\_PFM (one word, High Data Byte, and ACK are not used)

# 3. Read Byte/Word Protocol

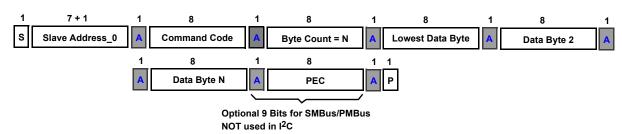


Example command: 8B READ\_VOUT (Two words, read voltage of the selected rail).

NOTE: That all Writable commands are read with one byte word protocol.

STOP (P) bit is NOT allowed before the repeated START condition when "reading" contents of a register.

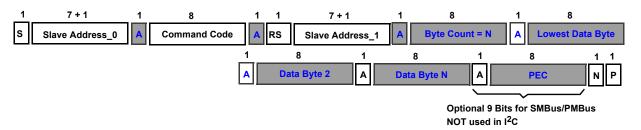
## 4. Block Write Protocol



Example command: ADh IC\_DEVICE\_ID (2 Data Byte)

FIGURE 23. SMBus/PMBus/I<sup>2</sup>C COMMAND PROTOCOL

# 5. Block Read Protocol



Example command: 8B READ\_VOUT (Two words, read voltage of the selected rail).

NOTE: That all Writable commands are read with one byte word protocol.

STOP (P) bit is NOT allowed before the repeated START condition when "reading" contents of a register.

#### 6. Group Command Protocol - No more than one command can be sent to the same Address

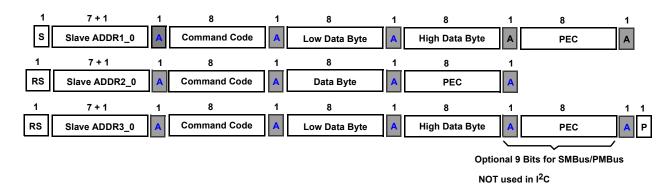


FIGURE 24. SMBus/PMBus/I<sup>2</sup>C COMMAND PROTOCOL

# TABLE 11. SMBus, PMBus, AND $I^2C$ SUPPORTED COMMANDS

COMMAND CODE	ACCESS	WORD LENGTH (BYTE)	DEFAULT VALUE	COMMAND NAME	DESCRIPTION
01h[7:0]	R/W	ONE	80h	OPERATION	VR Enable (depending upon ON_OFF_CONFIG configuration): Bit[7]: 0 = OFF (0-F); 1 = ON (80-8Fh) Bit[6:4] = 0 Bit[3:0] = Don't care
02h[7:0]	R/W	ONE	1Fh	ON_OFF_CONFIG	Configure VR Enabled by OPERATION and/or EN pin:  Bit[7:5] = 0  Bit[4] = 1  Bit[3] = OPERATION command Enable  Oh = OPERATION command has no control on VR  1h = OPERATION command can turn ON/OFF VR  Bit[2] = CONTROL pin Enable  Oh = EN Pin has no control on VR  1h = EN pin can turn ON/OFF VR  Bit[1] = 1  Bit[0] = 1  Bit[0] = 1  Bit[3:2] = 00b = 13h (ALWAYS ON)  Bit[3:2] = 01b = 17h (EN controls VR)  Bit[3:2] = 10b = 18h (OPERATION control VR)
03h	SEND BYTE	N/A		CLEAR_FAULTS	Clear faults in status registers
20h[7:0]	R	ONE	<b>1</b> 9h	VOUT_MODE	Set host format of V <sub>OUT</sub> command. Always Linear Format: N = -7
21h[2:0]	R/W	TWO	PROG1[7:0]	VOUT_COMMAND	Set output voltage HEX Code = DEC2HEX [ROUND(V <sub>OUT</sub> /2 <sup>-7</sup> )]
24h[15:0]	R/W	TWO	VBOOT+500mV	VOUT_MAX	Set maximum output voltage that VR can command (DAC ≤ VOUT_MAX). Linear Format. N = -7 HEX Code = DEC2HEX(ROUNDUP(VOUT_MAX/ 2 <sup>-7</sup> )
33h[15:0]	R/W	TWO	PROG3[5:3]	FREQUENCY_SWITCH	Set VR Switching Frequency (In Linear Format) Support 8 options (N = 0):  12Ch = 300kHz; 190h = 400kHz; 1F4h = 500kHz 258h = 600kHz; 2BCh = 700kHz; 352h = 850kHz 3E8h = 1MHz; 5DCh = 1.5MHz*  * Very high frequency is not recommended for very high duty cycle applications as the boot capacitor does not have enough time to be charged due to low LGATE ON time.
78h[8:0]	R	ONE		STATUS_BYTE	Fault Reporting; Bit7 = Busy Bit6 = OFF (Reflect current state of operation and ON_OFF_CONFIG registers as well as VR Operation) Bit5 = OVP Bit4 = OCP Bit3 = 0 Bit2 = OTP Bit1 = Bus communication error Bit0 = NONE OF ABOVE (OUTPUT UVP, VOUT_COMAND > VOUT_MAX, or VOUT OPEN SENSE)
88h[15:0]	R	TWO		READ_VIN	Input Voltage (N = - 4, Max = 31.9375V) VIN (V) = HEX2DEC(88 hex data - E000h) * 0.0625V
8Bh[15:0]	R	TWO		READ_VOUT	VR Output Voltage, Resolution = 7.8125mV = 2 <sup>-7</sup> VOUT (V) = HEX2DEC(8B hex data) * 2 <sup>-7</sup>
8Ch[15:0]	R	TWO		READ_IOUT	VR Output Current (N = -3, IMAX = 63.875A) IOUT (A) = HEX2DEC(8C hex data-E800) * 0.125A when IOUT pin voltage = 2.5V at 63.875A load.



TABLE 11. SMBus, PMBus, AND I<sup>2</sup>C SUPPORTED COMMANDS (Continued)

COMMAND CODE	ACCESS	WORD LENGTH (BYTE)	DEFAULT VALUE	COMMAND NAME	DESCRIPTION
8Dh[15:0]	R	TWO		READ_TEMP	VR Temperature TEMP (°C) = 1/{In[Rup*HEX2DEC(8D hex data)/(511 - HEX2DEC(8D hex data)/RNTC(at +25°C)]/Beta + 1/298.15} -273.15
98h[7:0]	R	ONE	02h	PMBUS_REVISION	Indicates PMBus Revision 1.2
AD[15:0]	BLOCK R	TWO	8201h	IC_DEVICE_ID	ISL68201 Device ID
AE[15:0]	BLOCK R	TWO	0003h	IC_DEVICE_REVISION	ISL68201 Device Revision
D0[0:0]	R/W	ONE	PROG2[7:7]	ENABLE_PFM	PFM OPERATION Oh = PFM Enabled (DCM at light load) 1h = PFM Disabled (always CCM mode)
D1[1:0]	R/W	ONE	PROG2[6:5]	TEMP_COMP	Thermal Compensation: 0h = 30°C; 01h = 15°C; 02h = 5°C; 03h = 0FF
D2[0:0]	R/W	ONE	PROG3[7:7]	ENABLE_ULTRASONIC	Ultrasonic PFM Enable  Oh = 25kHz Clamp Disabled  1h = 25kHz Clamp Enabled
D3[0:0]	R/W	ONE	PROG3[6:6]	OCP_BEHAVIOR	Set latch or infinite retry for OCP fault: 0h = Retry every 9ms; 01 = Latch-OFF
D4[2:0]	R/W	ONE	PROG3[2:0]	AV_GAIN	R4 AV GAIN (PROG4, AV Gain Multiplier = 2x)  0h = 84; 1h = 73; 2h = 61; 3h = 49  4h = 38; 5h = 26; 6h = 14; 7h = 2  R4 AV GAIN (PROG4, AV Gain Multiplier = 1x)  0h = 42; 1h = 36.5; 2h = 30.5; 3h = 29.5  4h = 19; 5h = 13; 6h = 7; 7h = 1
D5{2:0]	R/W	ONE	PROG4[7:5]	RAMP_RATE	Soft-Start and Margining DVID Rate (mV/µs) 0h = 1.25; 1h = 2.5; 2h = 5; 3h = 10; 4h = 0.078; 5h = 0.157 6h = 0.315; 7h = 0.625;
D6[1:0]	R/W	ONE	PROG4[4:3]	SET_RR	Set RR 0h = 200k; 01h = 400k; 02h = 600k; 03h = 800k
DC[7:0]	R	ONE		READ_PROG1	Read PROG1
DD{7:0]	R	ONE		READ_PROG2	Read PROG2
DE[7:0]	R	ONE		READ_PROG3	Read PROG3
DF[7:0]	R	ONE		READ_PROG4	Read PROG4

NOTE: Serial bus communication is valid 5.5m (typically, worst 6.5ms) after V<sub>CC</sub>, V<sub>IN</sub>, 7VLDO, and PVCC above POR. The telemetry update rate is 108µs.

#### **R4 Modulator**

The R4 modulator is an evolutionary step in R3 technology. Like R3, the R4 modulator is a linear control loop and variable frequency control during load transients to eliminate beat frequency oscillation at the switching frequency and maintains the benefits of current-mode hysteretic controllers. In addition, the R4 modulator reduces regulator output impedance and uses accurate referencing to eliminate the need for a high-gain voltage amplifier in the compensation loop. The result is a topology that can be tuned to voltage-mode hysteretic transient speed while maintaining a linear control model and removes the need for any compensation. This greatly simplifies the regulator design for customers and reduces external component cost.

## **STABILITY**

The removal of compensation derives from the R4 modulator's lack of need for high DC gain. In traditional architectures, high DC gain is achieved with an integrator in the voltage loop. The integrator introduces a pole in the open-loop transfer function at low frequencies. That, combined with the double-pole from the output L/C filter, creates a three pole system that must be compensated to maintain stability.

Classic control theory requires a single-pole transition through unity gain to ensure a stable system. Current-mode architectures (includes peak, peak-valley, current-mode hysteric, R3, and R4) generate a zero at or near the L/C resonant point, effectively canceling one of the system's poles. The system still contains two poles, one of which must be canceled with a zero before unity gain crossover to achieve stability.



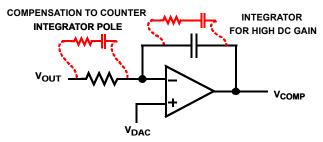


FIGURE 25. CLASSICAL INTEGRATOR ERROR-AMPLIFIER CONFIGURATION

Figure 25 illustrates the classic integrator configuration for a voltage loop error amplifier. While the integrator provides the high DC gain required for accurate regulation in traditional technologies, it also introduces a low-frequency pole into the control loop. Figure 26 shows the open-loop response that results from the addition of an integrating capacitor in the voltage loop. The compensation components found in Figure 25 are necessary to achieve stability.

Because R4 does not require a high-gain voltage loop, the integrator can be removed, reducing the number of inherent poles in the loop to two. The current-mode zero continues to cancel one of the poles, ensuring a single-pole crossover for a wide range of output filter choices. The result is a stable system with no need for compensation components or complex equations to properly tune the stability.

Figure 27 shows the R4 error amplifier that does not require an integrator for high DC gain to achieve accurate regulation. The result to the open loop response can be seen in Figure 28.

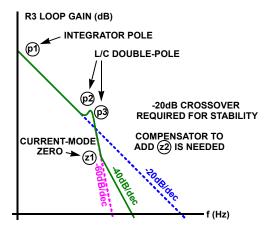


FIGURE 26. UNCOMPENSATED INTEGRATOR OPEN-LOOP RESPONSE

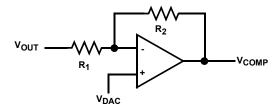


FIGURE 27. NON-INTEGRATED R4 ERROR-AMPLIFIER CONFIGURATION

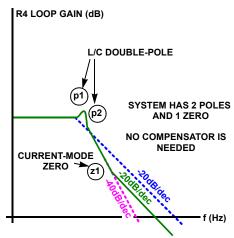


FIGURE 28. UNCOMPENSATED R4 OPEN-LOOP RESPONSE

#### **TRANSIENT RESPONSE**

In addition to requiring a compensation zero, the integrator in traditional architectures also slows system response to transient conditions. The change in COMP voltage is slow in response to a rapid change in output voltage. If the integrating capacitor is removed, COMP moves as quickly as  $V_{\rm OUT}$ , and the modulator immediately increases or decreases switching frequency to recover the output voltage.

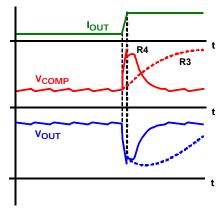


FIGURE 29. R3 vs R4 IDEALIZED TRANSIENT RESPONSE

The dotted red and blue lines in Figure 29 represent the time delayed behavior of  $V_{OUT}$  and  $V_{COMP}$  in response to a load transient when an integrator is used. The solid red and blue lines illustrate the increased response of R4 in the absence of the integrator capacitor.

To optimize transient response and improve phase margin for very wide range applications, the ISL68201 integrates selectable AV and RR options that move the DC gain and z1 point, as shown in Figure 28. However, the defaulted AV gain of 42 and RR of  $200 k\Omega$  can cover many cases and provides sufficient gain and phase margin. For some extreme cases, lower AV gain and bigger RR values are needed to provide a better phase margin and improve transient ringback. The optimal choice AV and RR can be obtained by simple monitoring transient response when adjusting AV and RR values through the serial bus.

# **General Application Design Guide**

This design guide provides a high-level explanation of the steps necessary to design a single-phase buck converter. It is assumed that the reader is familiar with many of the basic skills and techniques referenced in the following. In addition to this guide, complete reference designs that include schematics, bills of materials, and example board layouts are provided.

# **Output Filter Design**

The output inductors and the output capacitor bank together to form a low-pass filter responsible for smoothing the pulsating voltage at the phase nodes. The output filter also must provide the transient energy until the regulator can respond. The output filter limits the system transient response, because it has a low bandwidth compared to the switching frequency. The output capacitor must supply or sink load current while the current in the output inductors increases or decreases to meet the demand.

In high-speed converters, the output capacitor bank is usually the most costly (and often the largest) part of the circuit. Output filter design begins with minimizing the cost of this part of the circuit. The critical load parameters in choosing the output capacitors are the maximum size of the load step,  $\Delta l$ ; the load current slew rate, di/dt; and the maximum allowable output voltage deviation under transient loading,  $\Delta V_{MAX}$ . Capacitors are characterized according to their capacitance, ESR, and ESL (equivalent series inductance).

At the beginning of the load transient, the output capacitors supply all of the transient current. The output voltage initially deviates by an amount approximated by the voltage drop across the ESL. As the load current increases, the voltage drop across the ESR increases linearly until the load current reaches its final value. The capacitors selected must have sufficiently low ESL and ESR so that the total output voltage deviation is less than the allowable maximum. Neglecting the contribution of inductor current and regulator response, the output voltage initially deviates by an amount, as shown in Equation 15:

$$\Delta V \approx \Delta I \cdot ESR + \frac{ESL}{L_{OUT}} \cdot V_{IN} + \frac{1}{C_{OUT}} \cdot \frac{\Delta I}{8 \cdot N \cdot f_{SW}}$$

$$\Delta I = \frac{V_{OUT} \cdot (1 - D)}{L_{OUT} \cdot f_{SW}}$$
(EQ. 15)

The filter capacitor must have sufficiently low ESL and ESR so that  $\Delta V \le \Delta V_{MAX}$ .

Most capacitor solutions rely on a mixture of high-frequency capacitors with relatively low capacitance in combination with bulk capacitors having high capacitance but limited high-frequency performance. Minimizing the ESL of the high-frequency capacitors allows them to support the output voltage as the current increases. Minimizing the ESR of the bulk capacitors allows them to supply the increased current with less output voltage deviation. The ESR of the bulk capacitors also creates the majority of the output voltage ripple. As the bulk capacitors sink and source the inductor AC ripple current, a voltage develops across the bulk capacitor ESR equal to  $I_{\text{L(P-P)}}$  (ESR).

Thus, after the output capacitors are selected, the maximum allowable ripple voltage,  $V_{P-P(MAX)}$ , determines the lower limit on the inductance, as shown in <u>Equation 16</u>.

$$L_{OUT} \ge ESR \cdot \frac{V_{OUT} \cdot (V_{IN} - V_{OUT})}{f_{SW} \cdot V_{IN} \cdot V_{P-P(MAX)}}$$
 (EQ. 16)

Because the capacitors are supplying a decreasing portion of the load current while the regulator recovers from the transient, the capacitor voltage becomes slightly depleted. The output inductors must be capable of assuming the entire load current before the output voltage decreases more than  $\Delta V_{\mbox{\scriptsize MAX}}.$  This places an upper limit on inductance.

Equation 17 gives the upper limit on L for cases when the trailing edge of the current transient causes a greater output to voltage deviation than the leading edge. Equation 18 addresses the leading edge. Normally, the trailing edge dictates the selection of L because duty cycles are usually less than 50%. Nevertheless, both inequalities should be evaluated, and L should be selected based on the lower of the two results. In Equations 17 and 18, L is the per-channel inductance and C is the total output capacitance.

$$L_{OUT} \le \frac{2 \cdot C \cdot V_{OUT}}{(\Delta I)^2} \left[ \Delta V_{MAX} - (\Delta I \cdot ESR) \right]$$
 (EQ. 17)

$$L_{OUT} \le \frac{1.25 \cdot C}{(\Delta I)^2} \left[ \Delta V_{MAX} - (\Delta I \cdot ESR) \right] \left( V_{IN} - V_{OUT} \right) \tag{EQ. 18}$$

# **Input Capacitor Selection**

The input capacitors are responsible for sourcing the AC component of the input current flowing into the upper MOSFETs. Their RMS current capacity must be sufficient to handle the AC component of the current drawn by the upper MOSFETs, which is related to duty cycle and the number of active phases. The input RMS current can be calculated with Equation 19.

$$I_{IN, RMS} = \sqrt{(D - D^2) \cdot Io^2 + \frac{D}{12} \cdot (\Delta I)^2}$$
 (EQ. 19)

Use Figure 30 on page 29 to determine the input capacitor RMS current requirement given the duty cycle, maximum sustained output current ( $I_0$ ), and the ratio of the per-phase peak-to-peak inductor current ( $I_{L(P-P)}$  to  $I_0$ ). Select a bulk capacitor with a ripple current rating that minimizes the total number of input capacitors required to support the RMS current calculated. The voltage rating of the capacitors should also be at least 1.25 times greater than the maximum input voltage.

Low capacitance, high-frequency ceramic capacitors are needed in addition to the bulk capacitors to suppress leading and falling edge voltage spikes. The result of the high current slew rates produced by the upper MOSFETs turn on and off requires low ESL ceramic capacitors, which should be placed as close as possible to each upper MOSFET drain to minimize board parasitic impedances and maximize noise suppression.



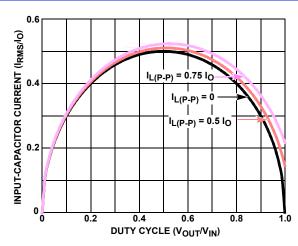


FIGURE 30. NORMALIZED INPUT-CAPACITOR RMS CURRENT vs DUTY CYCLE FOR SINGLE-PHASE CONVERTER

# **Design and Layout Considerations**

To ensure a first pass design, the schematics design must be done correctly with correct pinout and net names, and the board must be carefully laid out.

As a general rule, power layers should be close together, either on the top or bottom of the board, with the weak analog or logic signal layers on the opposite side of the board or internal layers. The ground-plane layer should be in between power layers and the signal layers to provide shielding, often the layer below the top and the layer above the bottom should be the ground layers.

The two sets of components in a DC/DC converter are the power components and the small signal components. The power components are the most critical because they switch large amounts of energy. The small signal components connect to sensitive nodes or supply critical bypassing current and signal coupling.

The power components should be placed first. These include MOSFETs, input and output capacitors, and the inductor. Keeping the distance between the power train and the control IC short helps keep the gate drive traces short. These drive signals include the LGATE, UGATE, GND, PHASE, and BOOT.

When placing MOSFETs, keep the source of the upper MOSFETs and the drain of the lower MOSFETs as close as thermally possible. Input high-frequency capacitors should be placed close to the drain of the upper MOSFETs and the source of the lower MOSFETs. Place the output inductor and output capacitors between the MOSFETs and the load. Place high frequency output decoupling capacitors (ceramic) as close as possible to the decoupling target, making use of the shortest connection paths to any internal planes. Place the components in such a way that the area under the IC has less noise traces with high dV/dt and di/dt, such as gate signals, phase node signals, and VIN plane.

<u>Tables 12</u> and <u>13</u> provide a design and layout checklist that the designer can reference.

**TABLE 12. DESIGN AND LAYOUT CHECKLIST** 

PIN NAME	NOISE SENSITIVITY	DESCRIPTION
EN	YES	There is an internal 1µs filter. Decoupling the capacitor is NOT needed, but if needed, use a low time constant one to avoid too large a shutdown delay.
VIN	YES	Place 16V+ X7R 1µF in close proximity to the pin and the system ground plane.
7VLDO	YES	Place 10V+ X7R 1µF in close proximity to the pin and the system ground plane.
vcc	YES	Place X7R 1µF in close proximity to the pin and the system ground plane.
SCL, SDA	YES	50kHz to 1.25MHz signal when the SMBus, PMBus, or I <sup>2</sup> C is sending commands. Pairing up with SALERT and routing carefully back to SMBus, PMBus or I <sup>2</sup> C master. 20 mils spacing within SDA, SALERT, and SCL; and more than 30 mils to all other signals. Refer to the SMBus, PMBus or I <sup>2</sup> C design guidelines and place proper terminated (pull-up) resistance for impedance matching. Tie them to GND when not used.
SALERT	NO	Open-drain and high dv/dt pin during transitions. Route it in the middle of SDA and SCL. Tie it to GND when not used.
PGOOD	NO	Open-drain pin. Tie it to GND when not used.
RGND, VSEN	YES	Differential pair routed to the remote sensing points with sufficient decoupling ceramics capacitors and not across or go above/under any switching nodes (BOOT, PHASE, UGATE, LGATE) or planes (VIN, PHASE, VOUT) even though they are not in the same layer. At least 20 mils spacing from other traces. DO NOT share the same trace with CSRTN.
CSRTN	YES	Connect to the output rail side of the output inductor or current sensing resistor pin with a series resistor in close proximity to the pin. The series resistor sets the current gain and should be within 40 $\Omega$ and 3.5k $\Omega$ . Decoupling ( $\sim 0.1 \mu F/X7R$ ) on the output end (not the pin) is optional and might be required for long sense trace and a poor layout (see Figures 9 and 10).
CSEN	YES	Connect to the phase node side of the output inductor or current sensing resistor pin with L/DCR or ESL/R <sub>SEN</sub> matching network in close proximity to CSEN and CSRTN pins.  Differentially routing back to the controller with at least 20 mils spacing from other traces. Should NOT cross or go above/under the switching nodes [BOOT, PHASE, UGATE, LGATE], and power planes (VIN, PHASE, VOUT) even though they are not in the same layer.

TABLE 12. DESIGN AND LAYOUT CHECKLIST (Continued)

Diri	Noise	
PIN NAME	NOISE SENSITIVITY	DESCRIPTION
NTC	YES	Place an NTC 10k (Murata, NCP15XH103J03RC, $\beta$ = 3380) in close proximity to the output inductor's output rail, not close to MOSFET side (see Figure 19); the return trace should be 20 mils away from other traces. Place 1.54k $\Omega$ pull-up and decoupling capacitor (typically 0.1 $\mu$ F) in close proximity to the controller. The pull-up resistor should be exactly tied to the same point as VCC pin, not through an RC filter. If not used, connect this pin to VCC.
IOUT	YES	Scale R so that the IOUT pin voltage is 2.5V at 63.875A load. Place R and C in general proximity to the controller. The time constant of RC should be sufficient as an averaging function (>200µs) for the digital IOUT. An external pull-up resistor to VCC placeholder is recommended to cancel IOUT offset at 0A load. See "IOUT. Calibration" on page 19
PROG1-4	NO	The resistor divider must be referenced to VCC pin and the system ground (GND); they can be placed anywhere. DO NOT use decoupling capacitors on these pins.
GND	YES	Directly connect to a low noise area of the system ground. The GND PAD should use at least four vias. Separate analog ground and power ground with a $0\Omega$ resistor is highly NOT recommended.
FCCM	NO	DO NOT place it across or under external components of the controller. Keep it at least 20 mils away from sensitive nodes.
PWM	NO	DO NOT place it across or under external components of the controller. Keep it at least 20 mils away from any other traces.
LGIN	NO	Keep it at least 20 mils away from sensitive nodes. A series $100\Omega$ resistor to low-side gate signal is required for noise attenuation.
PVCC	YES	Place X7R 4.7µF in proximity to the PVCC pin and the system ground plane.

**TABLE 13. TOP LAYOUT TIPS** 

NUMBER	DESCRIPTION
1	The layer next to controller (top or bottom) should be a ground layer. Separate analog ground and power ground with a $0\Omega$ resistor is highly NOT recommended. Directly connect GND PAD to low noise area of the system ground with at least four vias.
2	Never place controller and its external components above or under VIN plane or any switching nodes.
3	Never share CSRTN and VSEN on the same trace.
4	Place the input rail decoupling ceramic capacitors closely to the high-side FET on the same layer as possible. Never use only one via and a trace connect the input rail decoupling ceramics capacitors; must connect to VIN and GND planes.
5	Place all decoupling capacitors in close proximity to the controller and the system ground plane.
6	Connect remote sense (VSEN and RGND) to the load and ceramic decoupling capacitors nodes; never run this pair above or below switching noise plane.
7	Always double check critical component pinout and their respective footprints.

# **Voltage Regulator Design Materials**

To support VR design and layout, Renesas also developed a set of tools and evaluation boards, as listed in <u>Table 14</u> and <u>Ordering Information</u> on <u>page 5</u>. Contact the local office or field <u>support</u> for the latest available information.

TABLE 14. AVAILABLE DESIGN ASSISTANCE MATERIALS

ITEM	DESCRIPTION
1	SMBus/PMBus/I <sup>2</sup> C communication tool with the PowerNavigator GUI.
2	Evaluation board schematics in OrCAD format and layout in Allegro format. See Ordering Information on page 5 for details.

# **Revision History** The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please visit our website to make sure you have the latest revision.

DATE	REVISION	CHANGE
Jul 12, 2018	FN8696.5	Updated Ordering information table by adding tape and reel options to table and updating Note 1. Updated Equation 10. Removed About Intersil section and updated disclaimer.
Oct 17, 2017	FN8696.4	Updated Pin 11 and 12 descriptions on page 6.
Sep 25, 2017	FN8696.3	Updated LGIN pin description. Updated Figure 4, changed " $10.2V/9.24V$ " to " $10.08V/9.12V$ ". Updated 3Fh R <sub>UP</sub> value in Table 3. Replaced entire paragraph on page 11. Added units to R = $348\Omega$ on page 17 above Figure 11. On page 28 last sentence in paragraph in left column changed " $I_{C(P-P)}$ " to " $I_{L(P-P)}$ ".
Aug 29, 2017	FN8696.2	For Figures 1 and 2 on page 3, added a resistor to the CSRTN circuit.  On page 1, updated the Related Literature section to current standards.  Added three demonstration boards to the Ordering Information table on page 5.  Removed Table 15 on page 30 because the demonstration board information is in the Ordering Information section.
Mar 7, 2016	FN8696.1	Removed unreleased parts from Table 1.
Mar 2, 2016	FN8696.0	Initial release

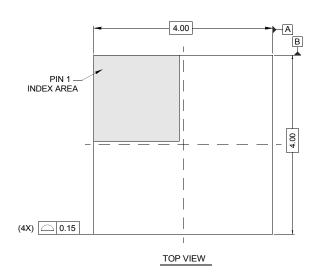


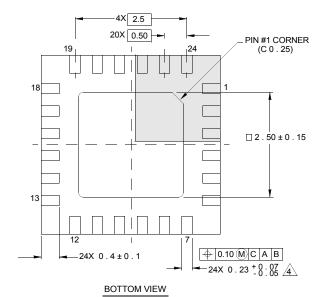
# **Package Outline Drawing**

L24.4x4C

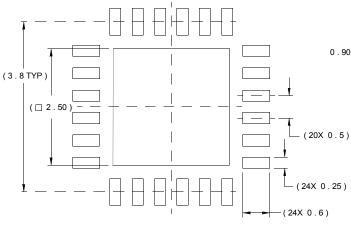
24 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE

Rev 2, 10/06

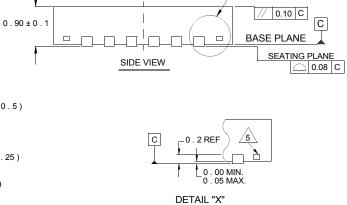




For the most recent package outline drawing, see <u>L24.4x4C</u>.



TYPICAL RECOMMENDED LAND PATTERN



## NOTES:

- Dimensions are in millimeters.
   Dimensions in ( ) for Reference Only.
- 2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
- 3. Unless otherwise specified, tolerance: Decimal ± 0.05
- 4. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
- 5. Tiebar shown (if present) is a non-functional feature.
- The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

SEE DETAIL "X"

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